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(19) **United States**(12) **Patent Application Publication****Al-Ali et al.**(10) **Pub. No.: US 2006/0211922 A1**(43) **Pub. Date: Sep. 21, 2006**(54) **MULTIPLE WAVELENGTH SENSOR  
SUBSTRATE**

on Mar. 1, 2005. Provisional application No. 60/657,268, filed on Mar. 1, 2005. Provisional application No. 60/657,759, filed on Mar. 1, 2005.

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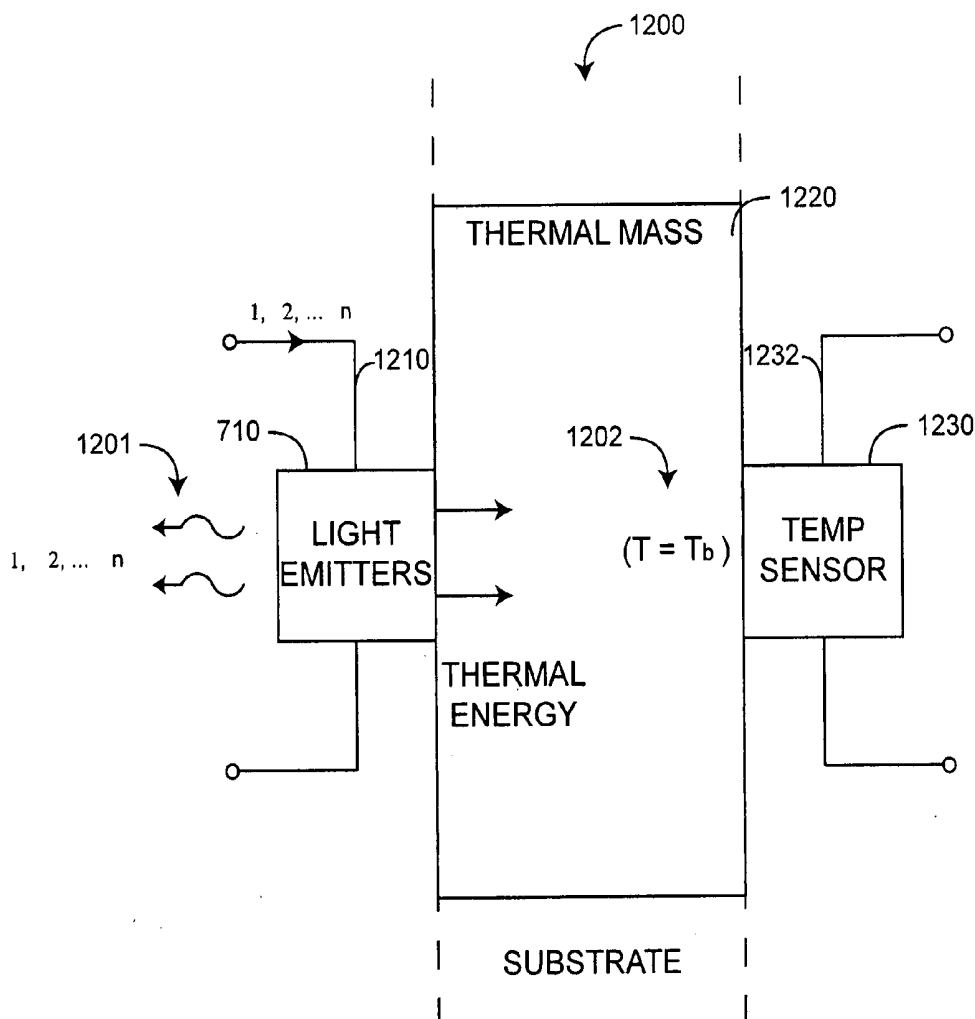
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**2040 MAIN STREET**  
**FOURTEENTH FLOOR**  
**IRVINE, CA 92614 (US)**

(21) Appl. No.: **11/366,209**(22) Filed: **Mar. 1, 2006****Related U.S. Application Data**

(60) Provisional application No. 60/657,596, filed on Mar. 1, 2005. Provisional application No. 60/657,281, filed

(57) **ABSTRACT**

A physiological sensor has emitters configured to transmit optical radiation having multiple wavelengths in response to corresponding drive currents. A thermal mass is disposed proximate the emitters so as to stabilize a bulk temperature for the emitters. A temperature sensor is thermally coupled to the thermal mass. The temperature sensor provides a temperature sensor output responsive to the bulk temperature so that the wavelengths are determinable as a function of the drive currents and the bulk temperature.



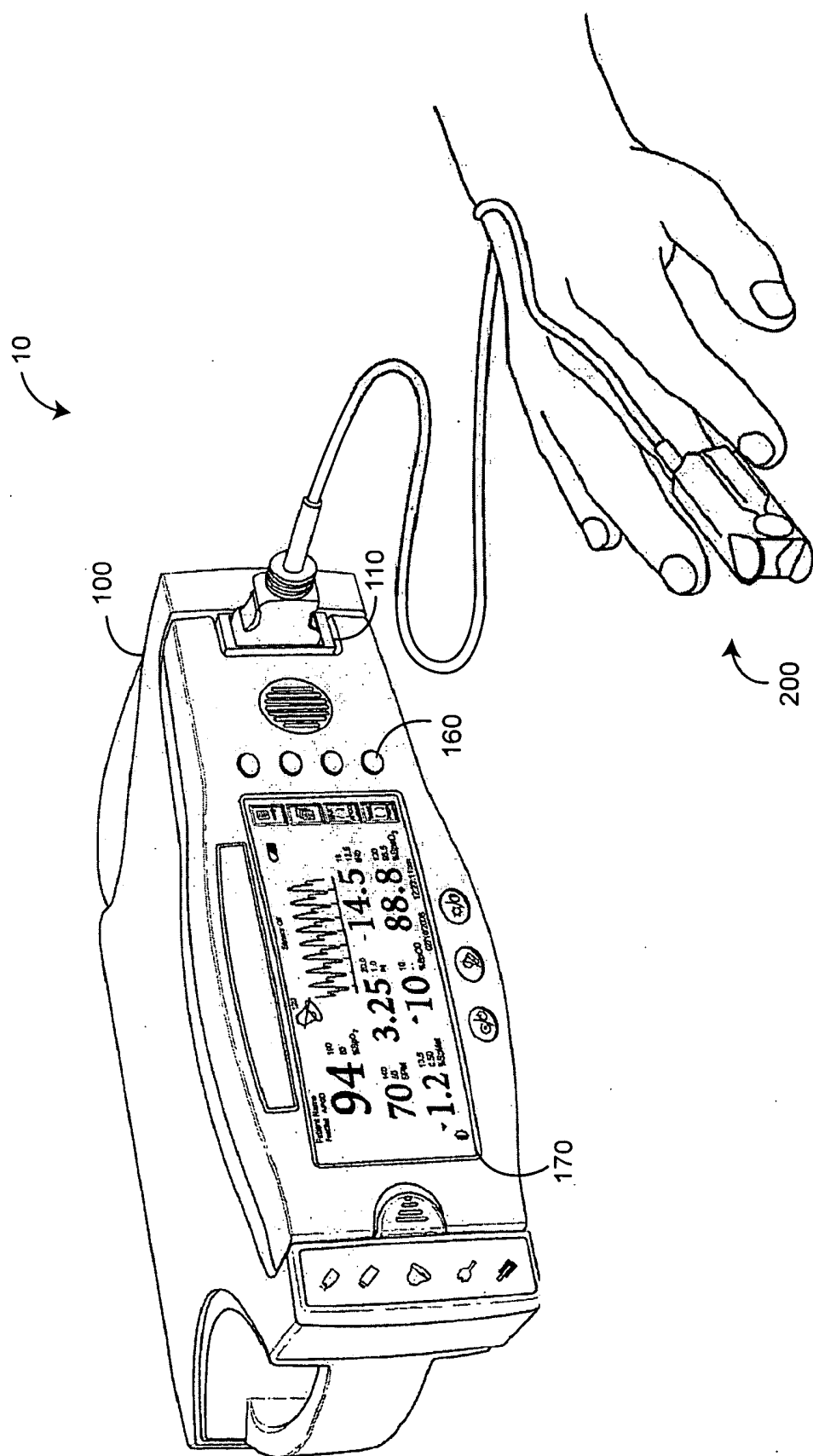


FIG. 1

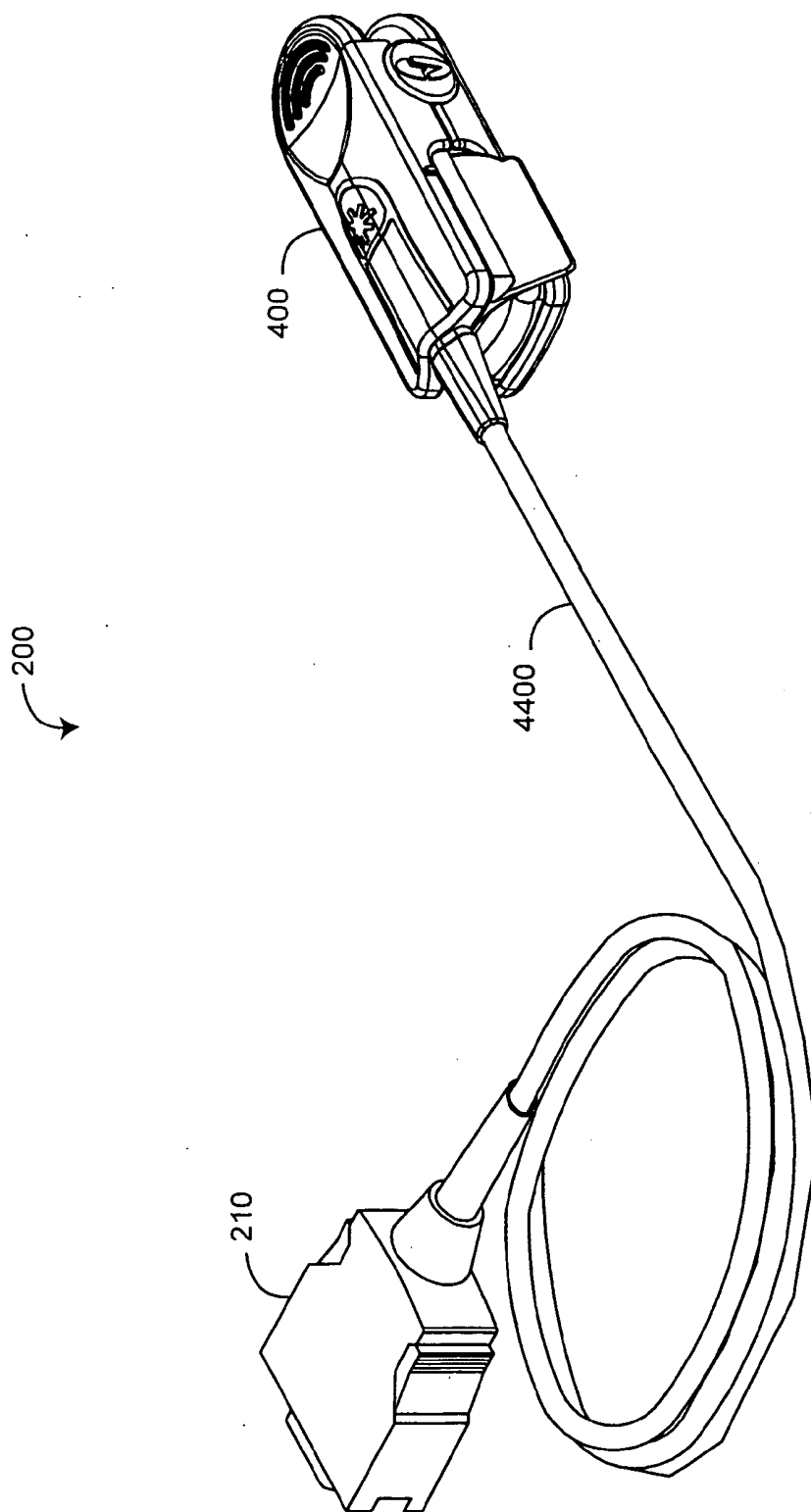


FIG. 2A

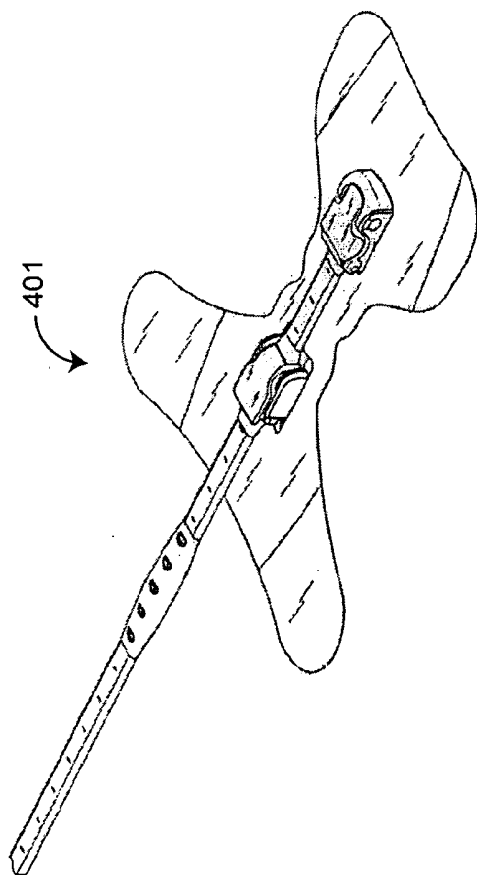


FIG. 2B

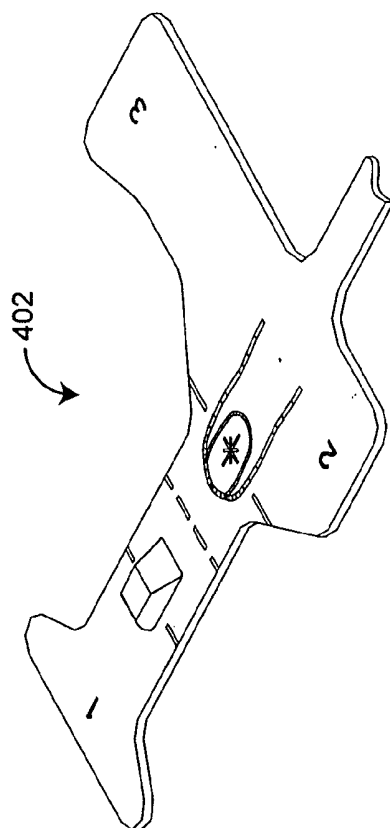


FIG. 2C

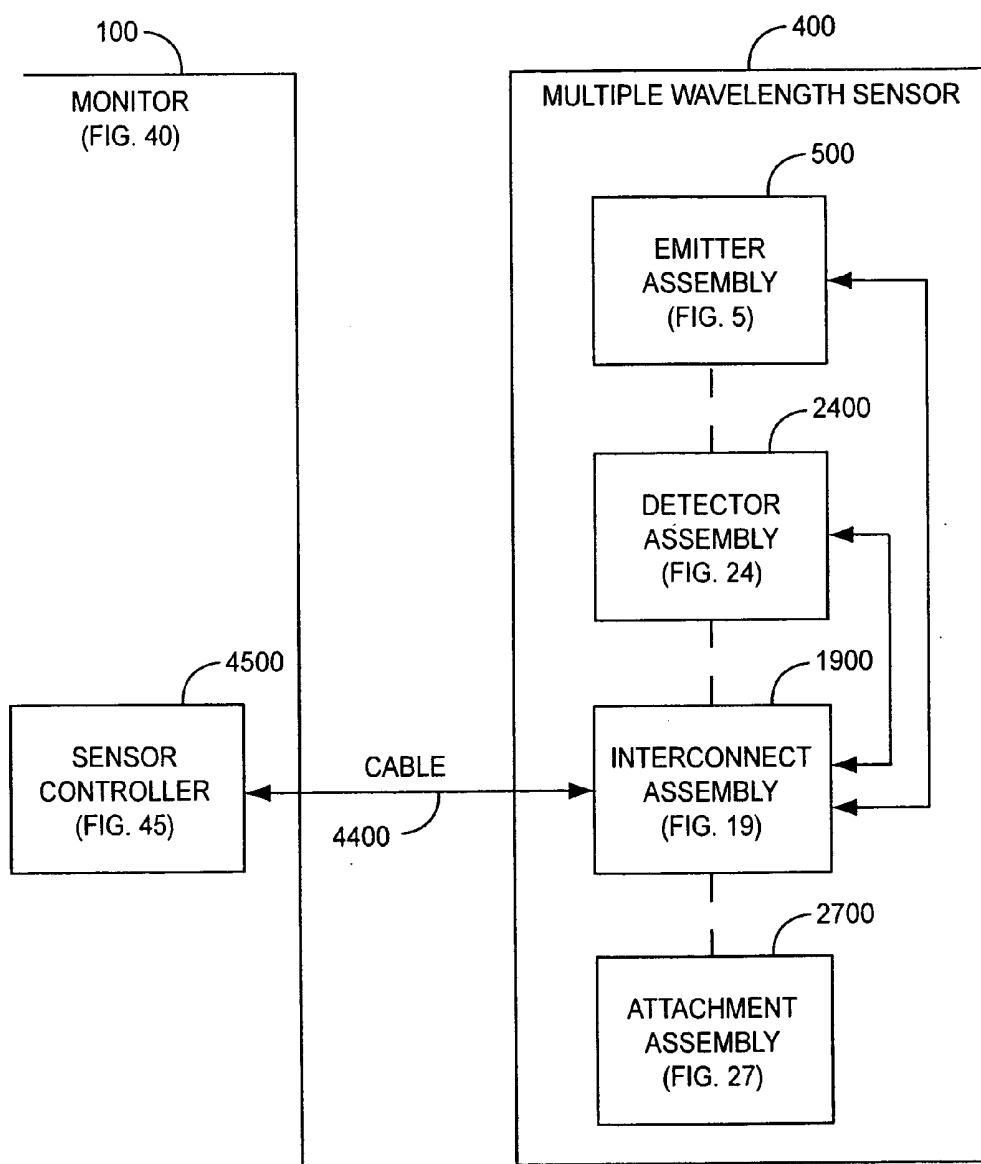


FIG. 3

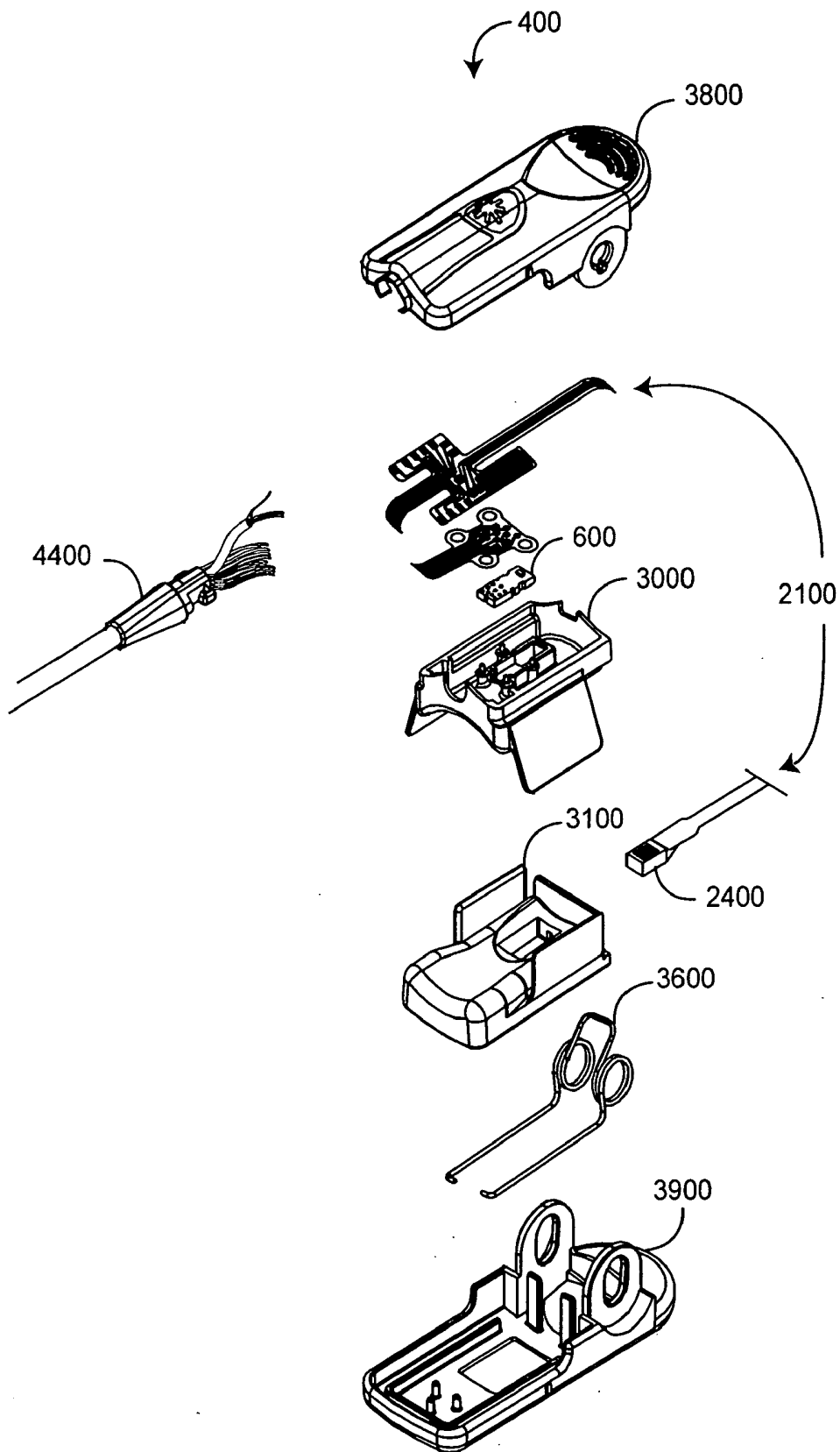


FIG. 4

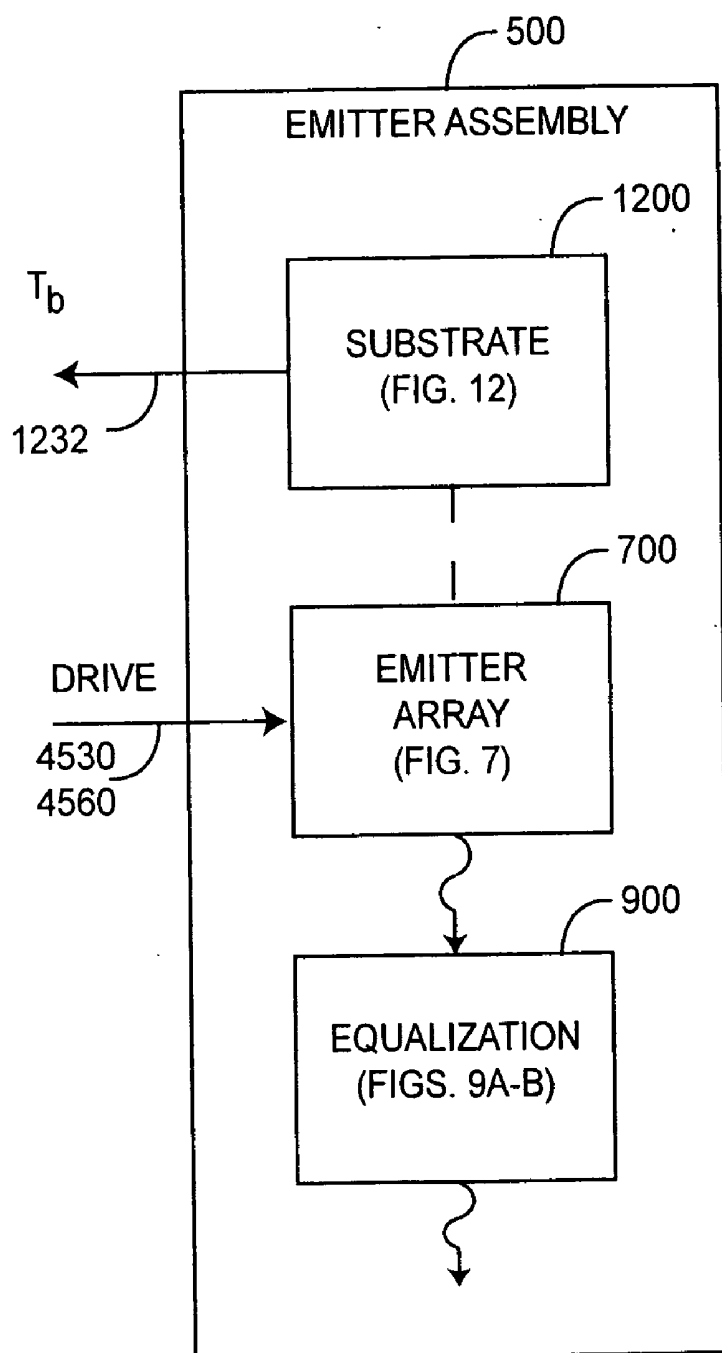


FIG. 5

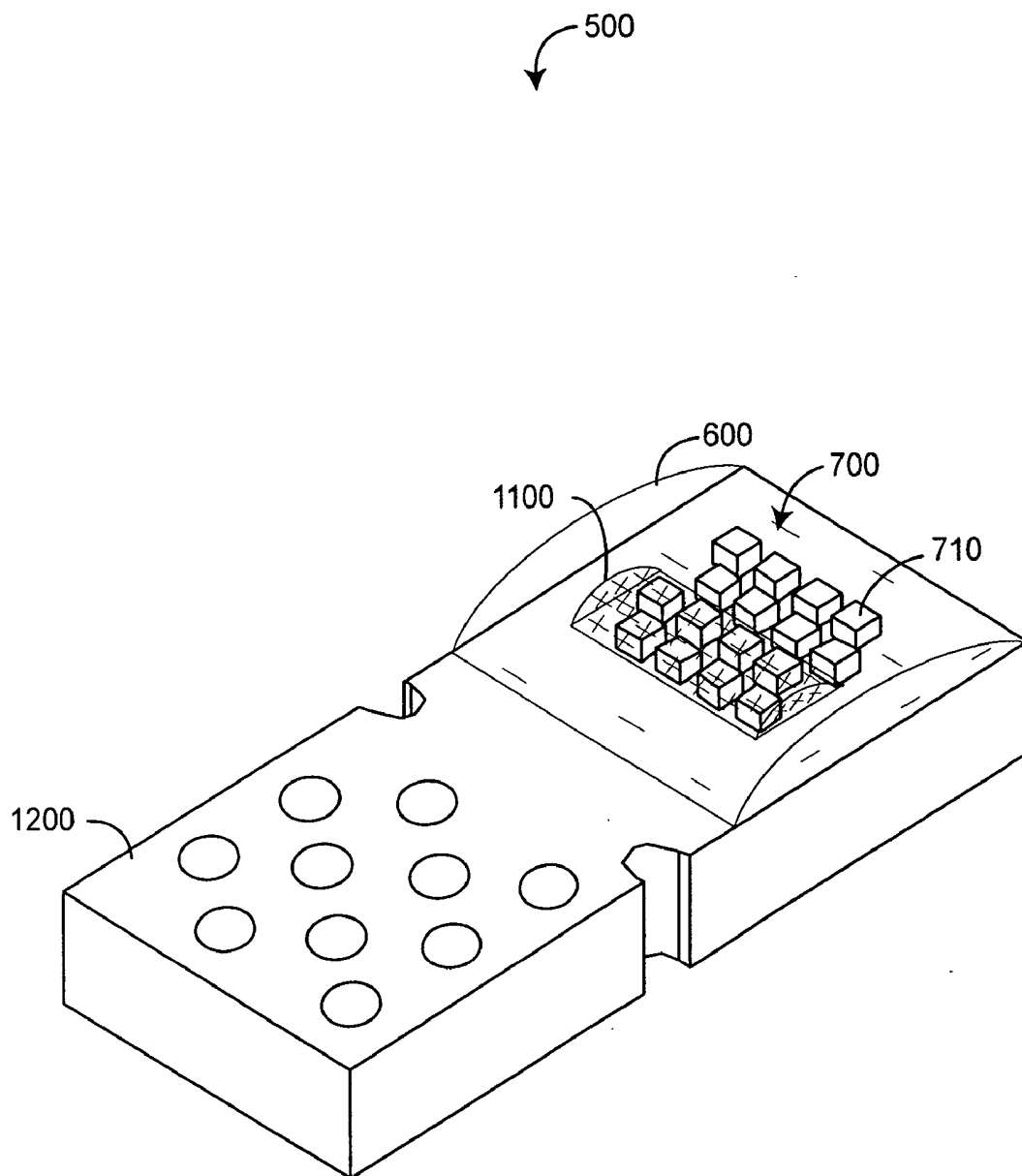


FIG. 6



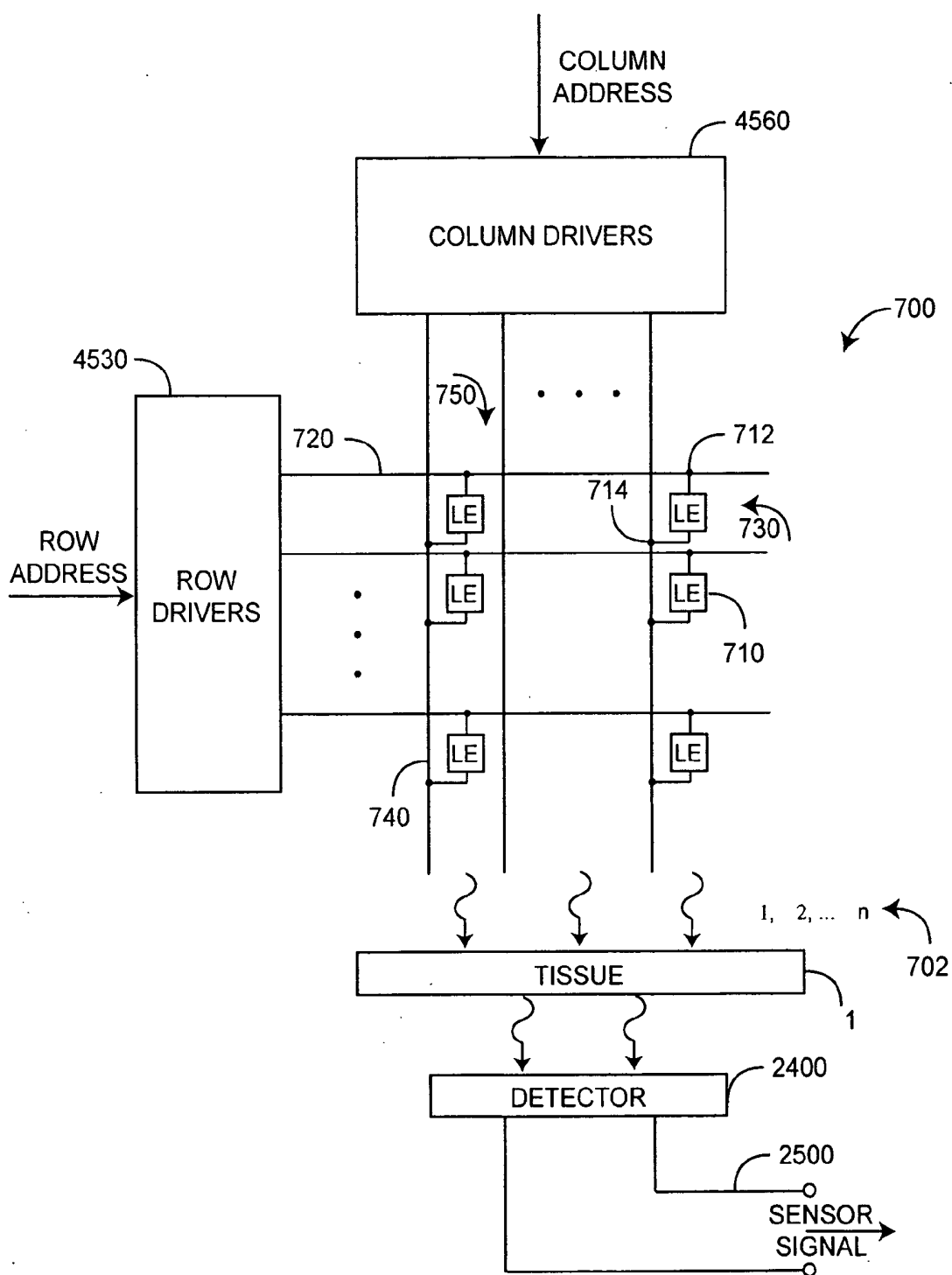


FIG. 7

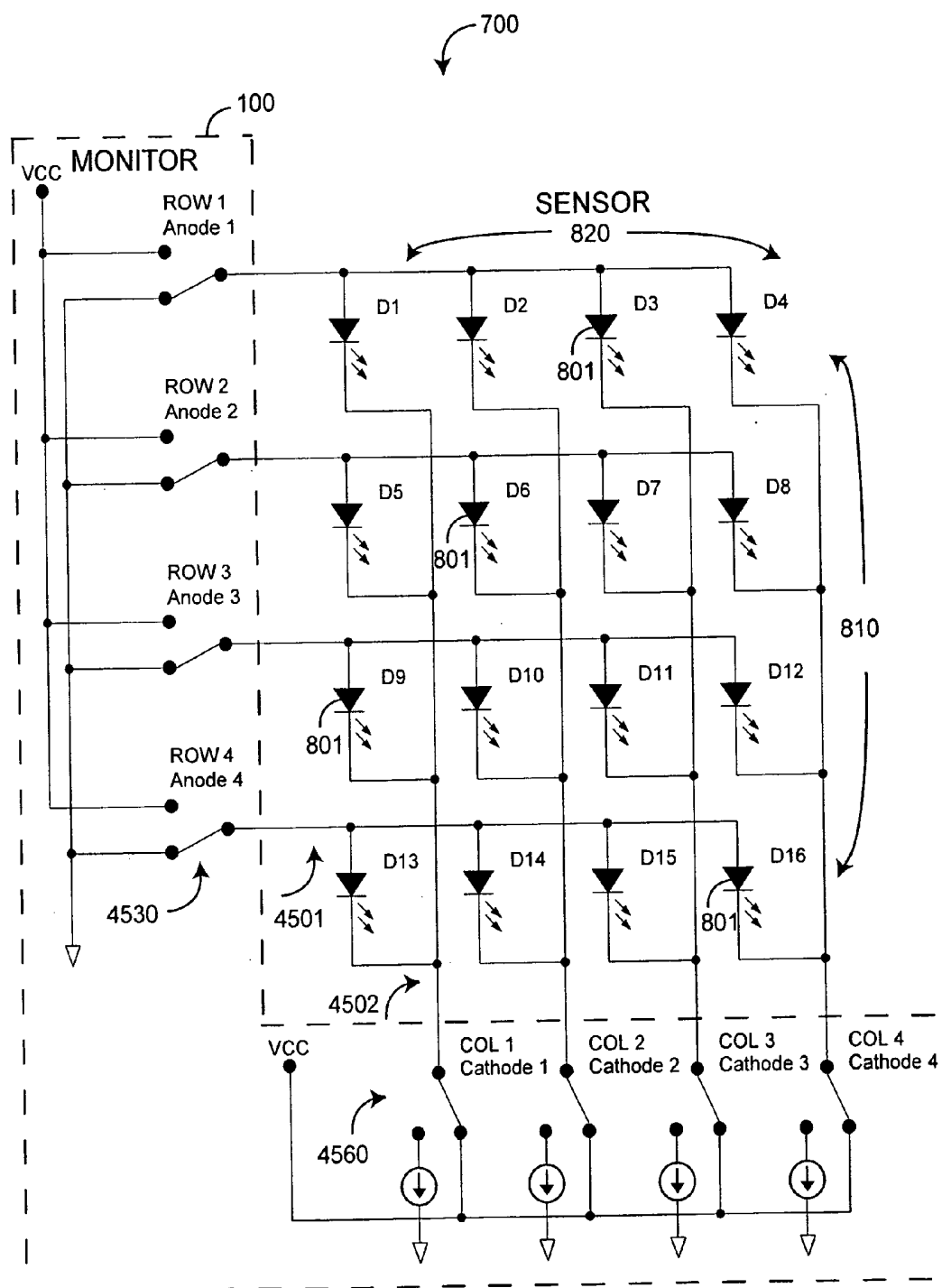


FIG. 8

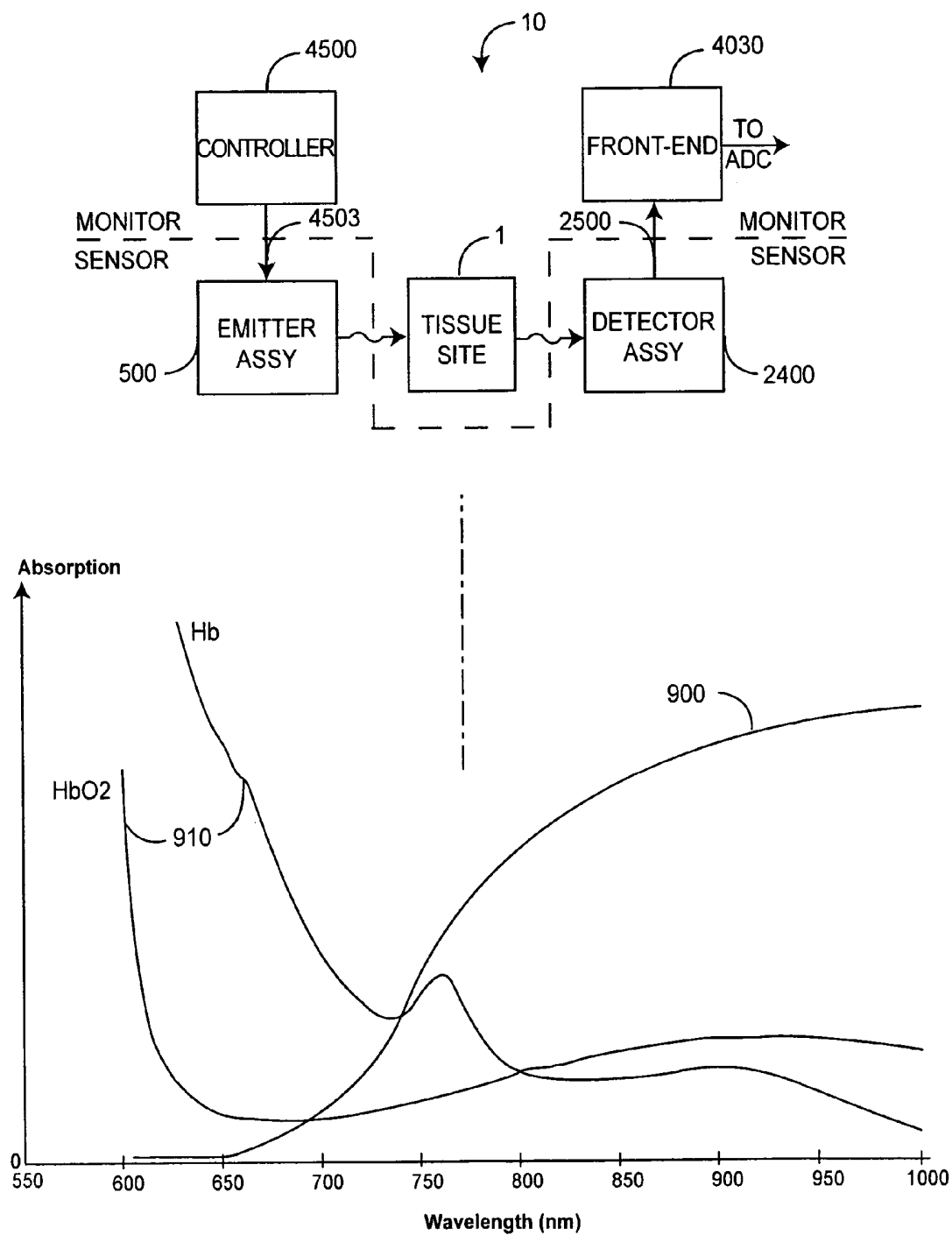


FIG. 9

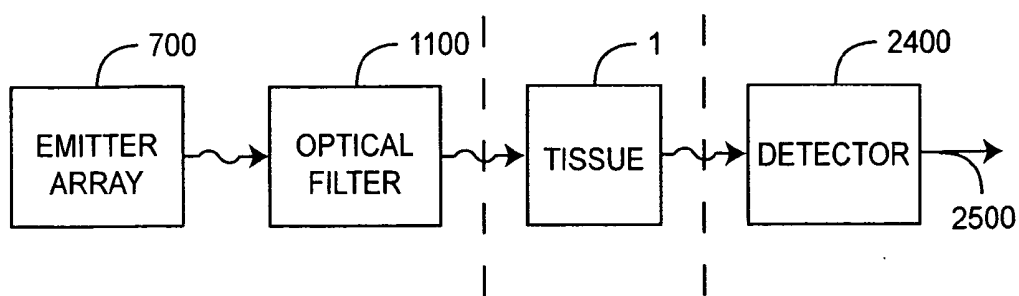


FIG. 10A

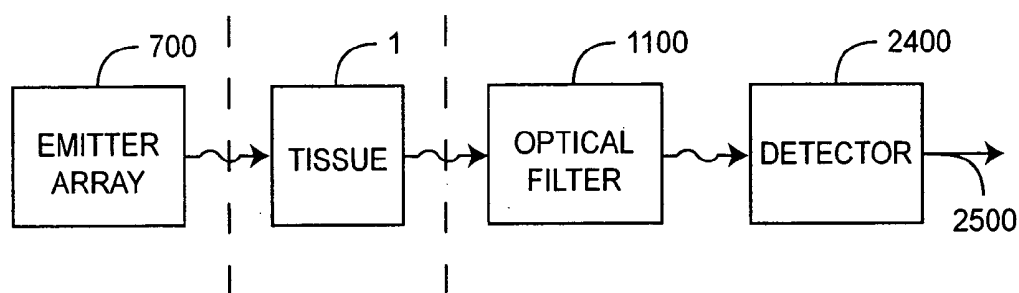


FIG. 10B

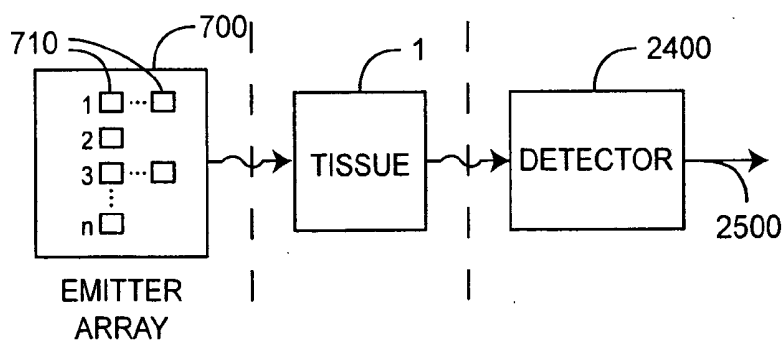


FIG. 10C

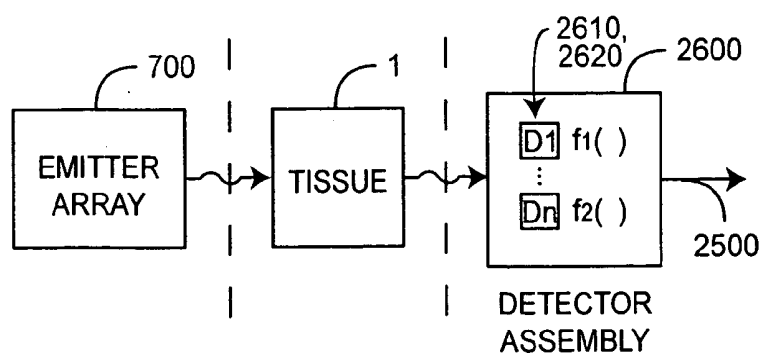


FIG. 10D

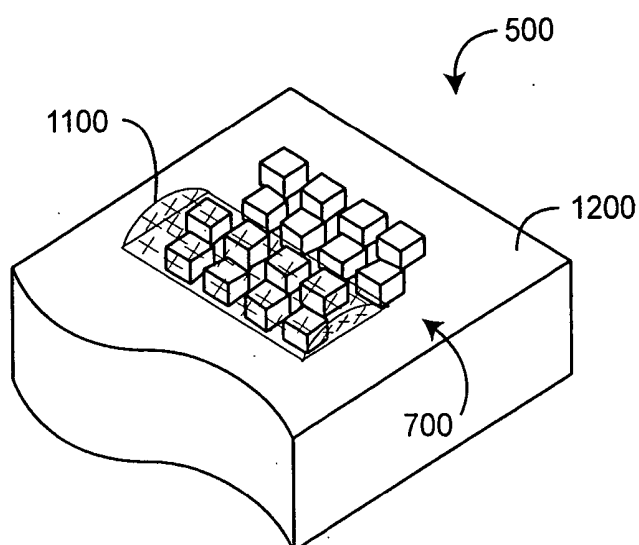


FIG. 11A

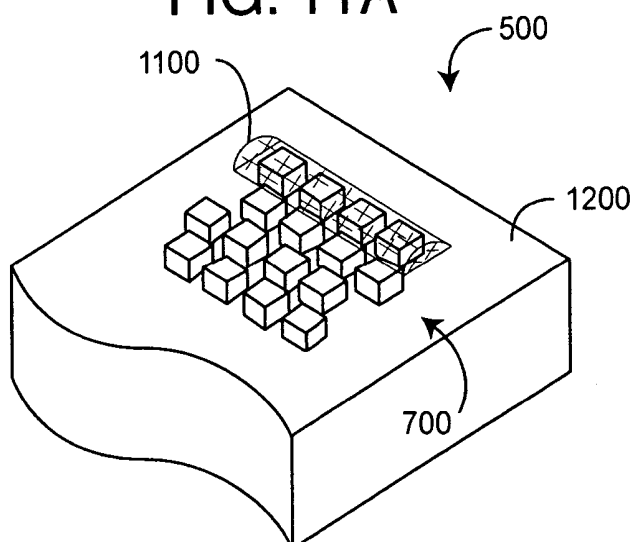


FIG. 11B

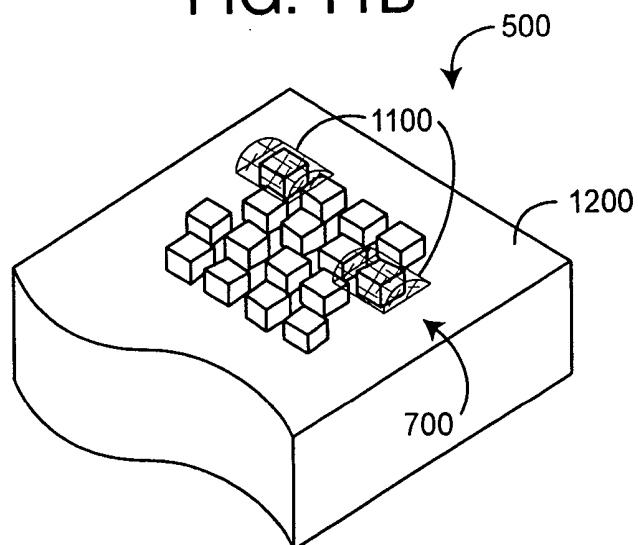


FIG. 11C

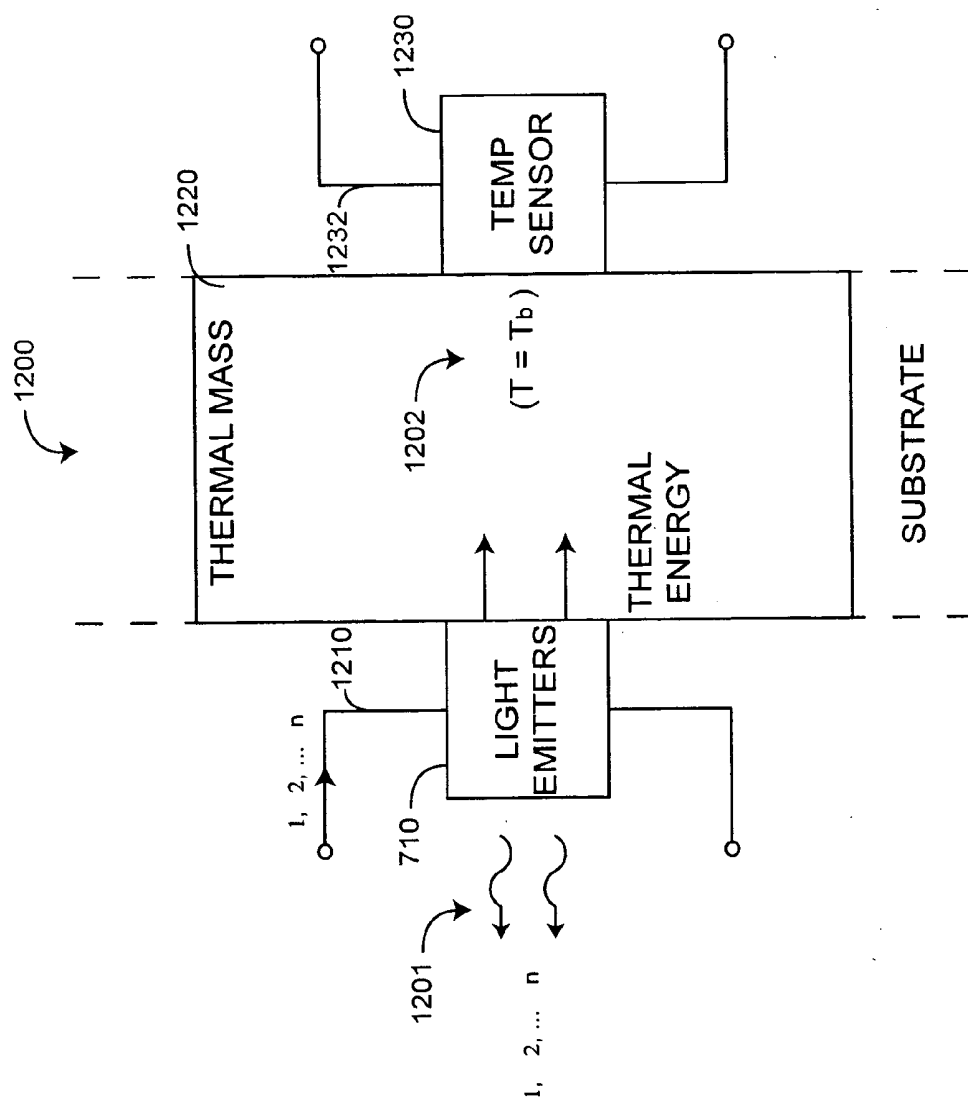
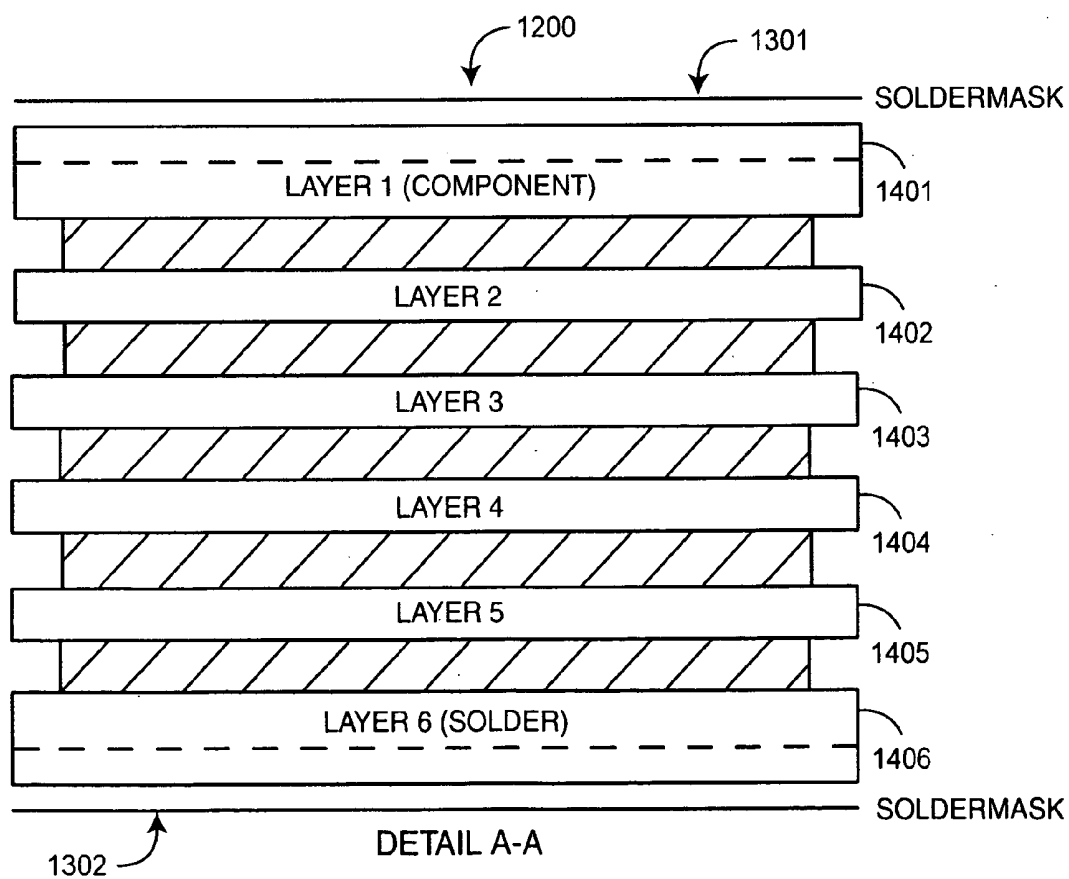
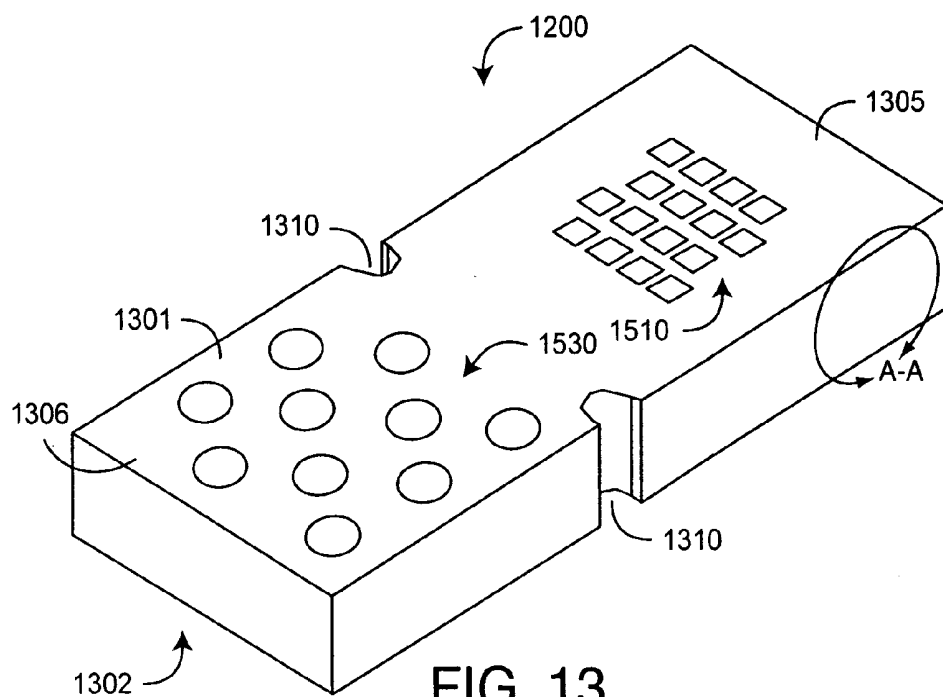


FIG. 12



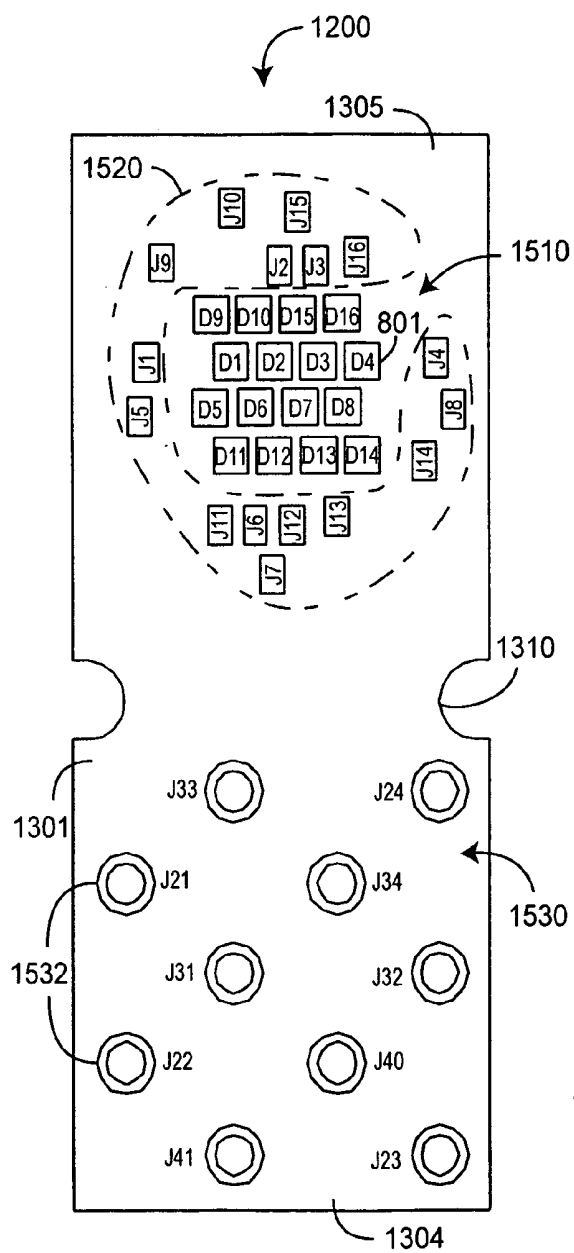


FIG. 15

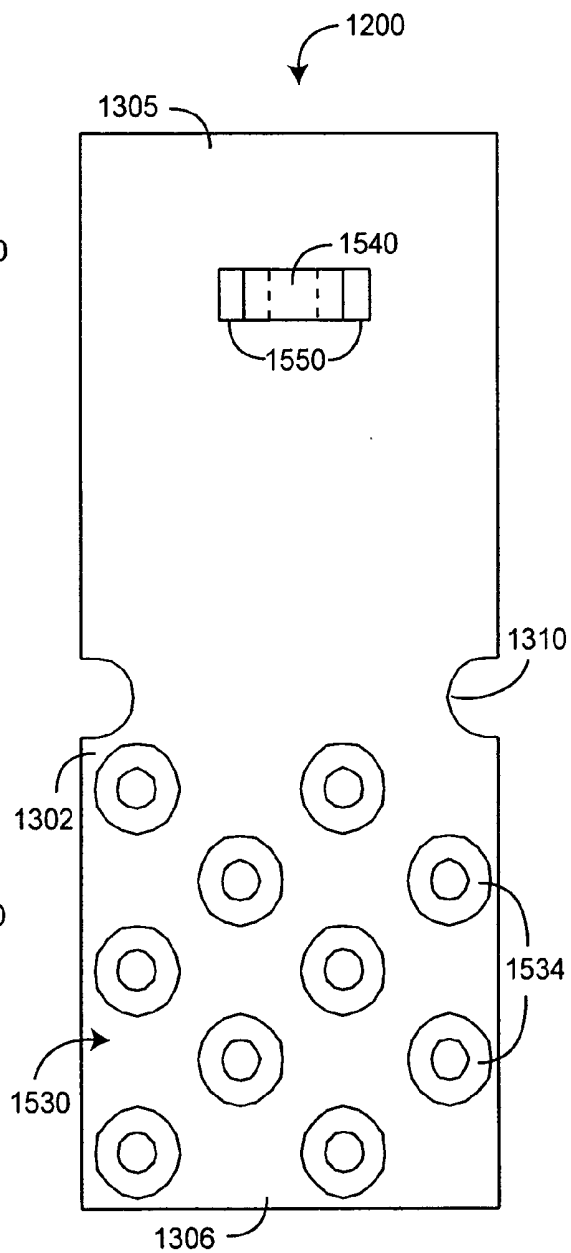


FIG. 16





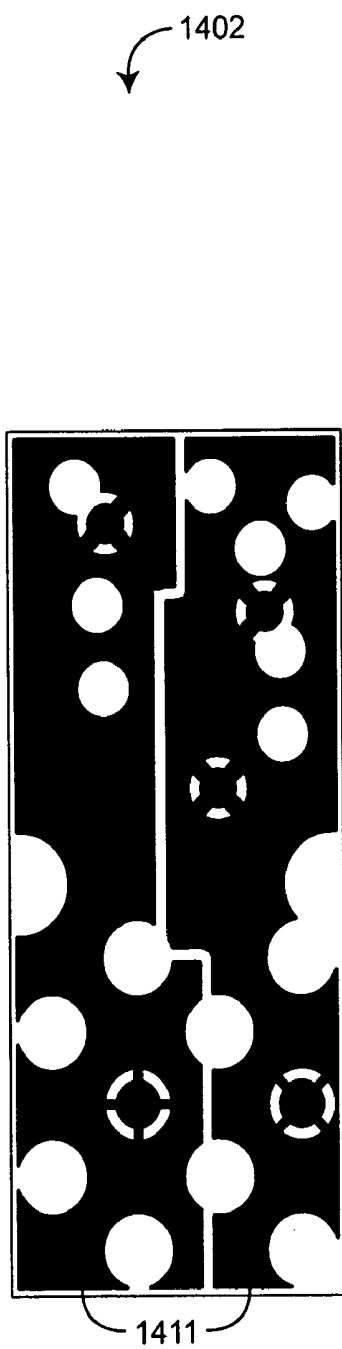


FIG. 18

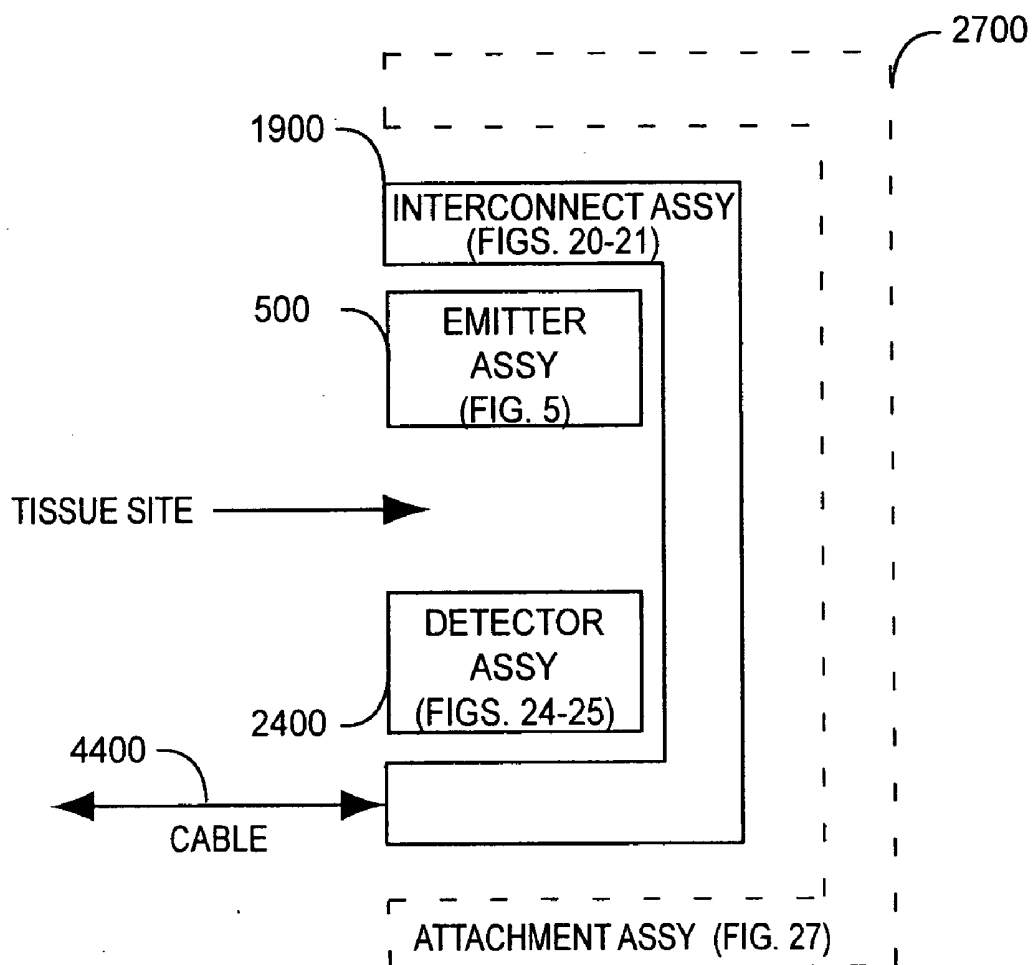


FIG. 19

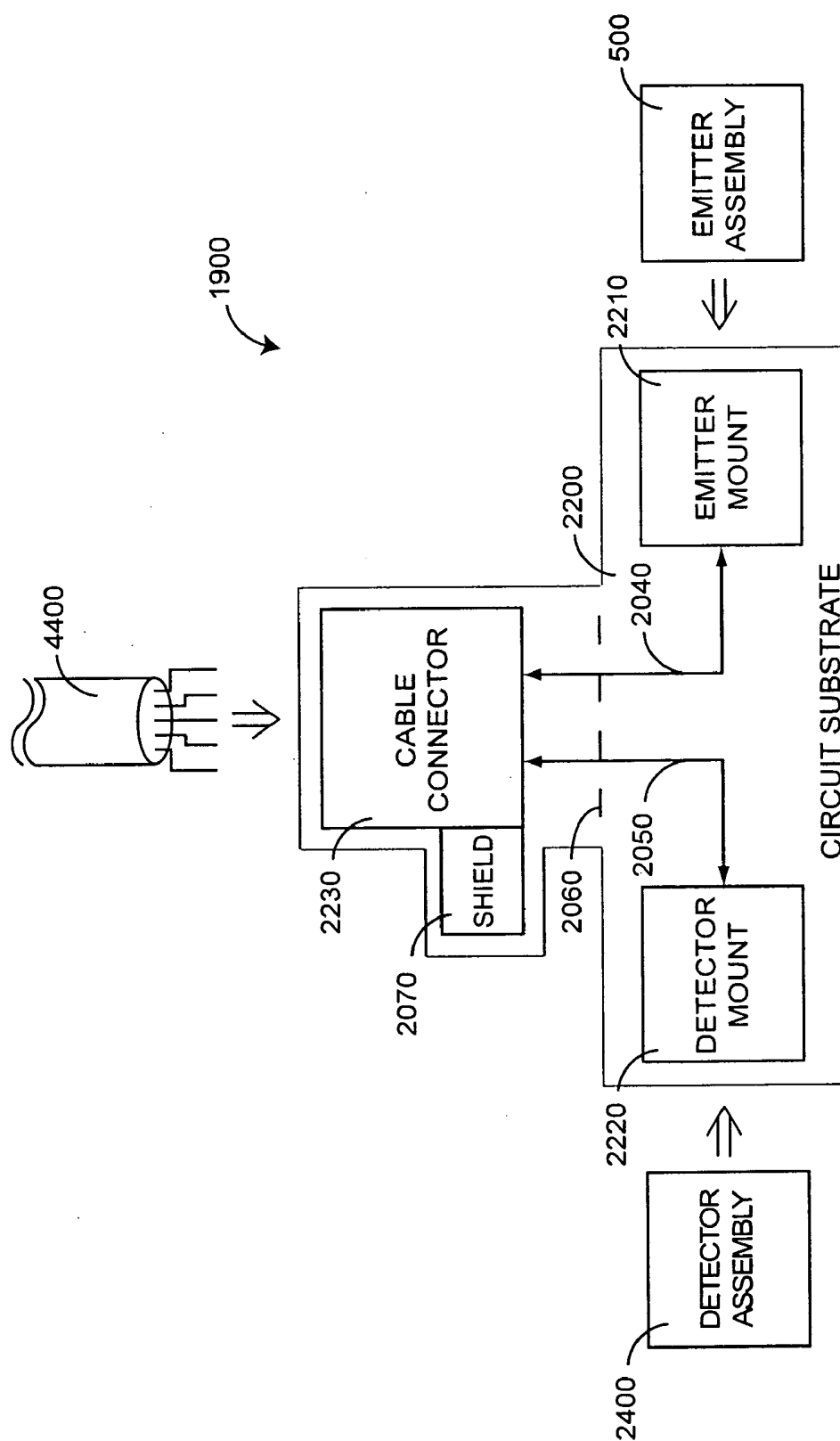


FIG. 20

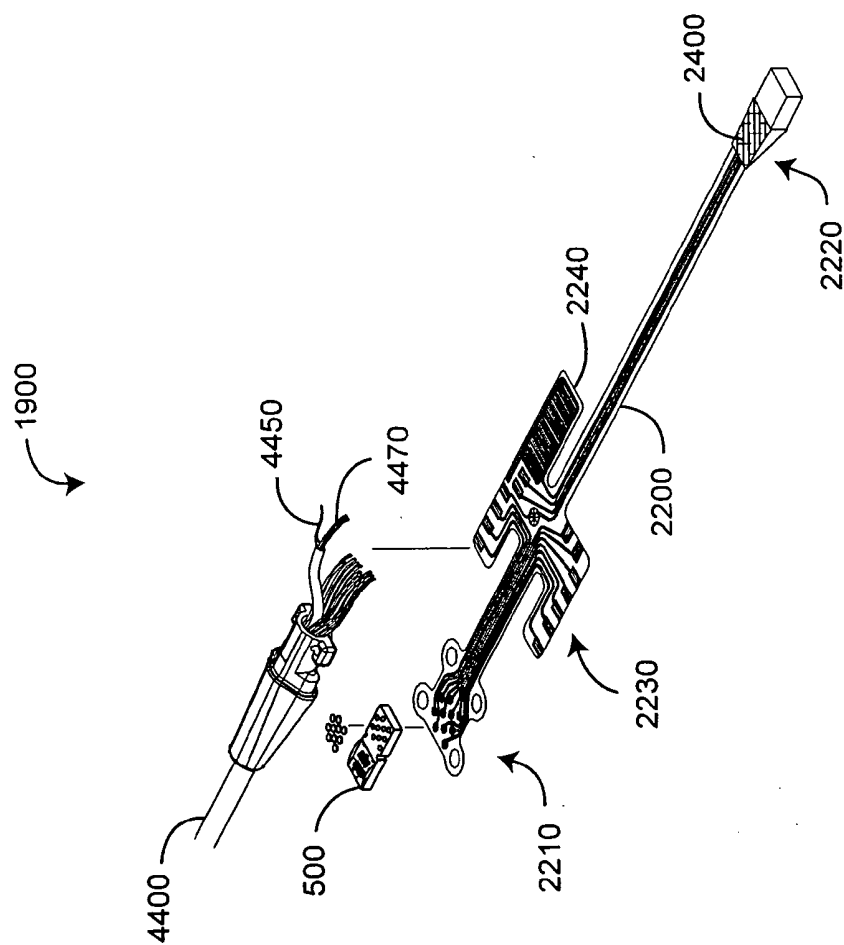


FIG. 21

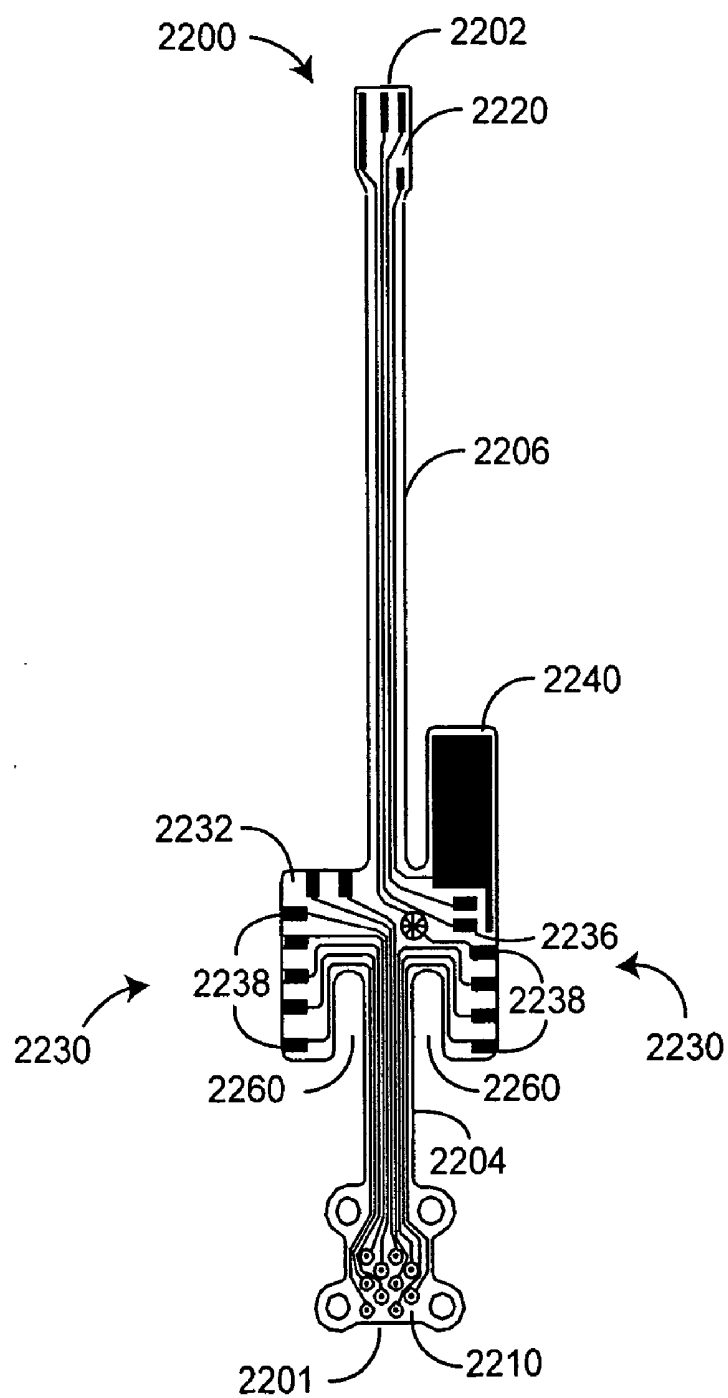


FIG. 22

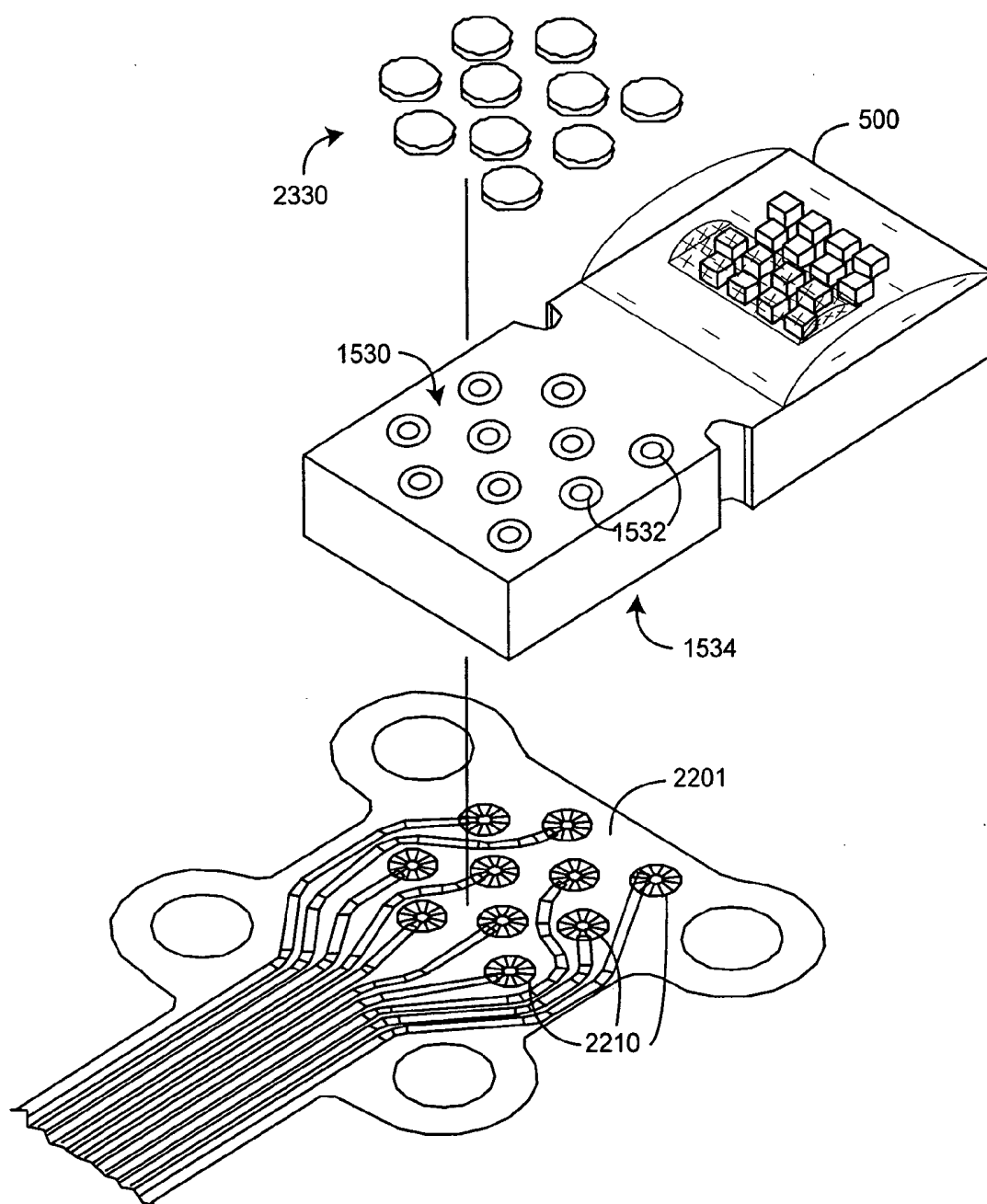


FIG. 23

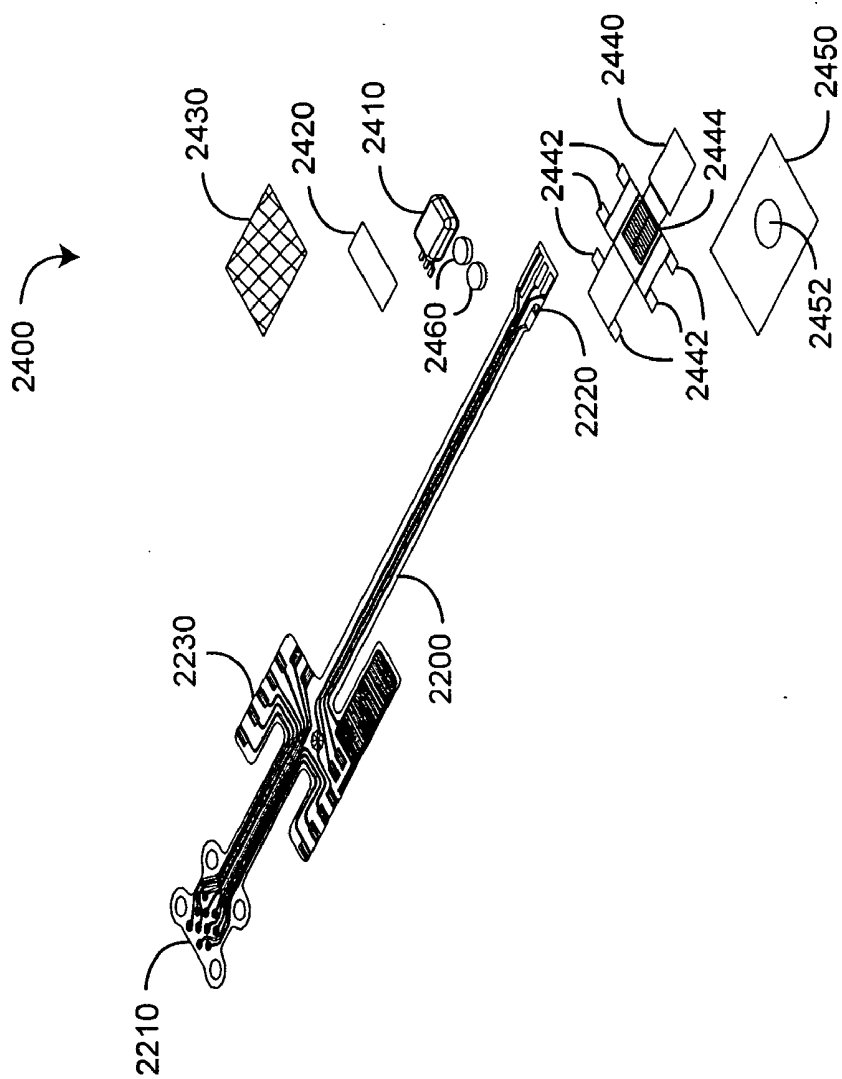


FIG. 24



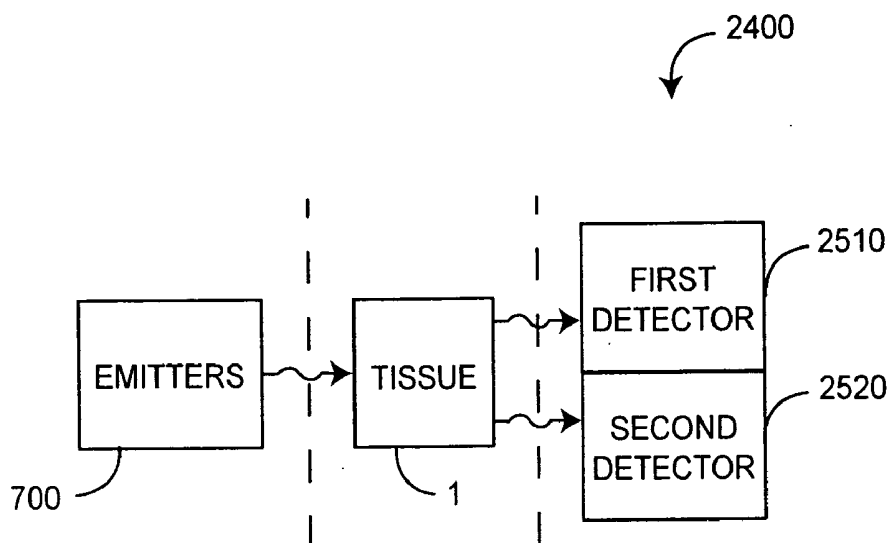


FIG. 25

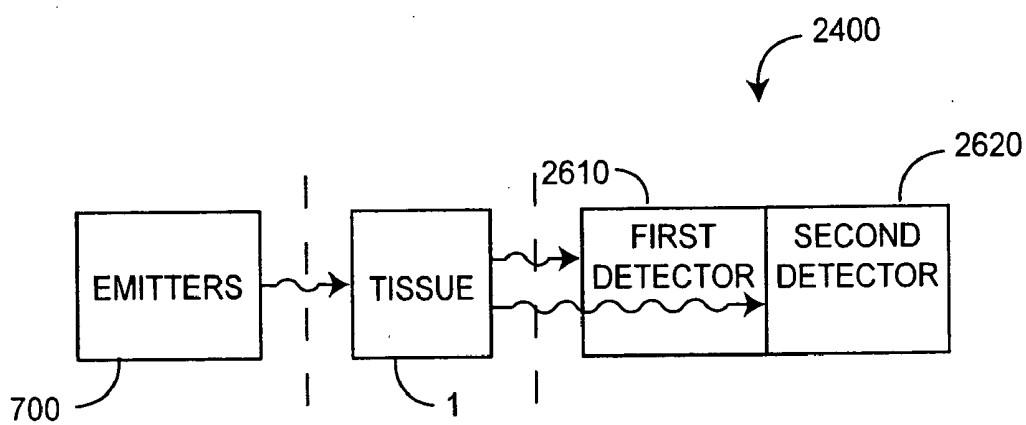


FIG. 26

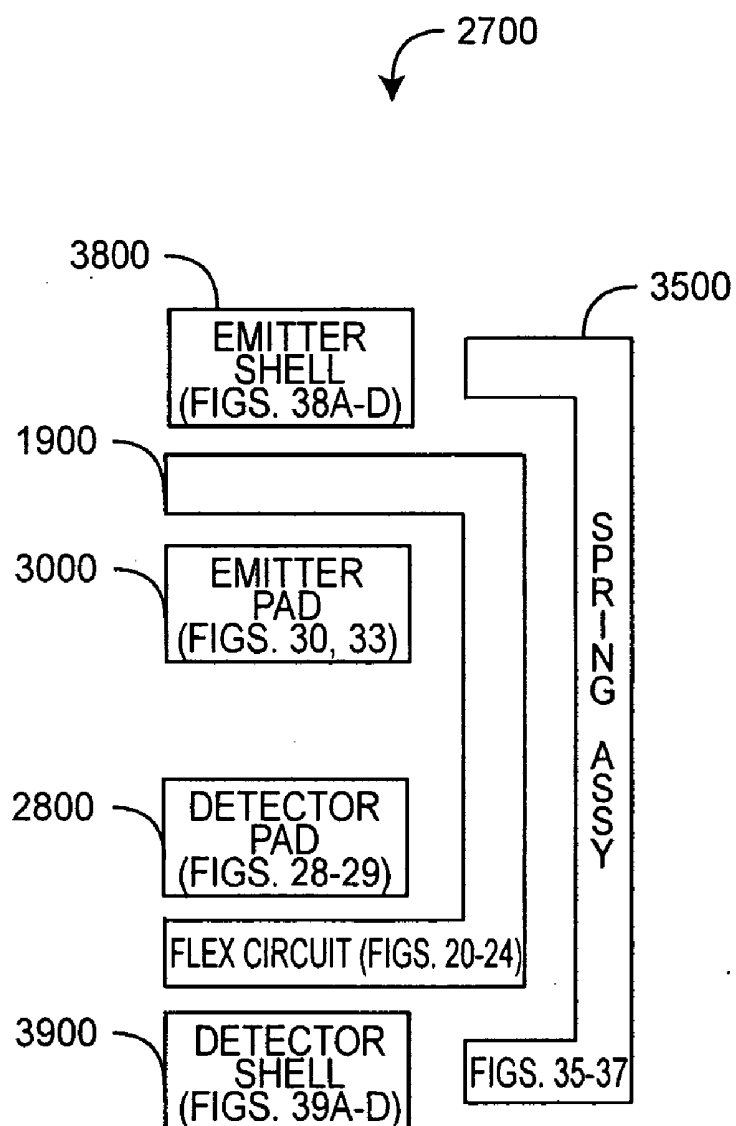


FIG. 27

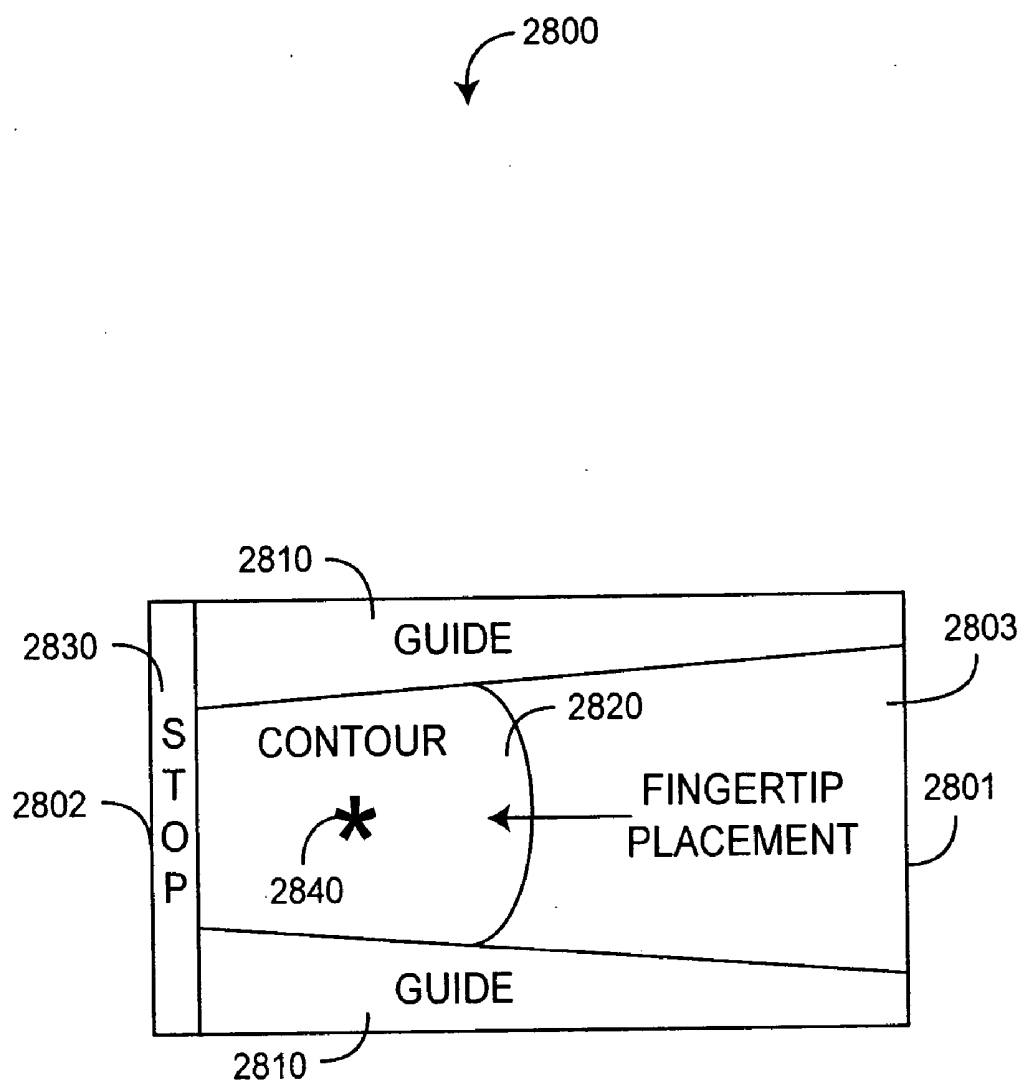


FIG. 28

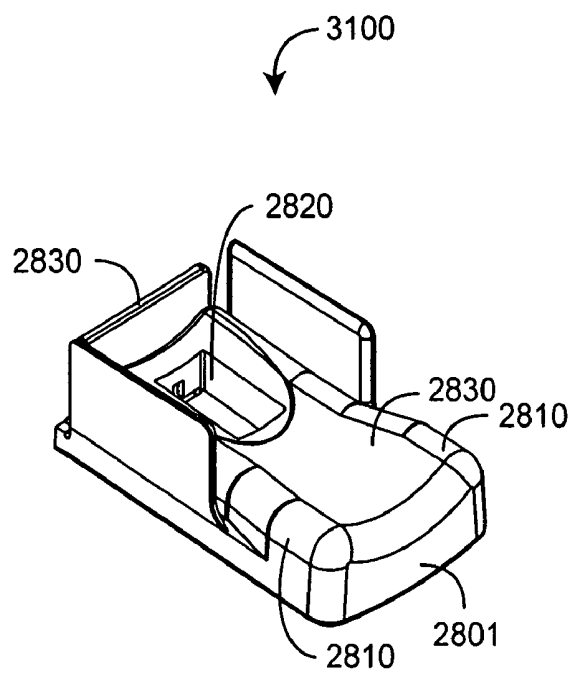


FIG. 29A

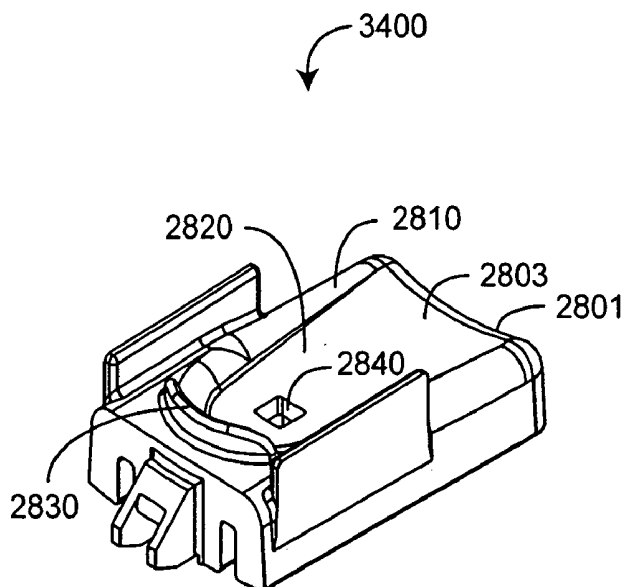


FIG. 29B

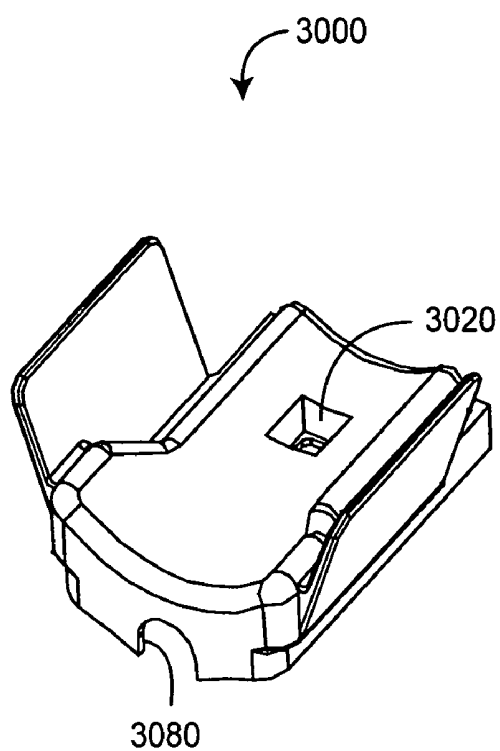


FIG. 30A

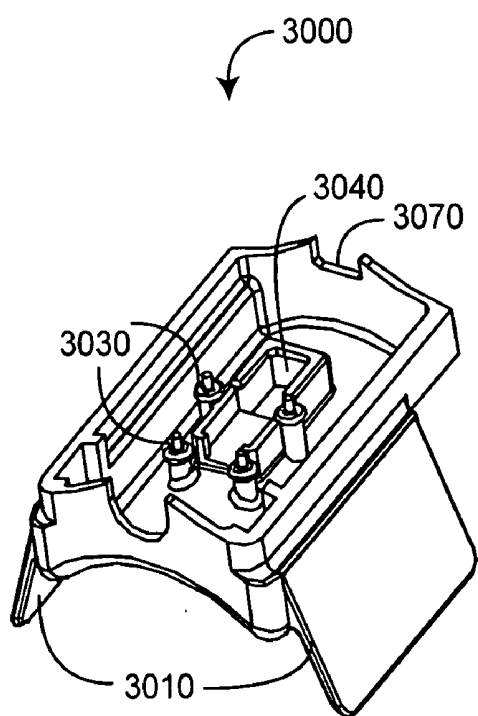


FIG. 30B

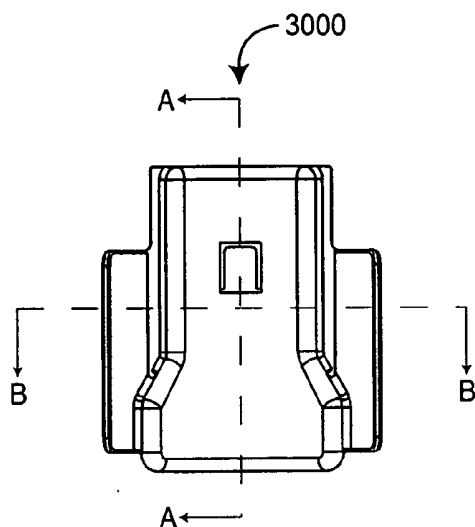
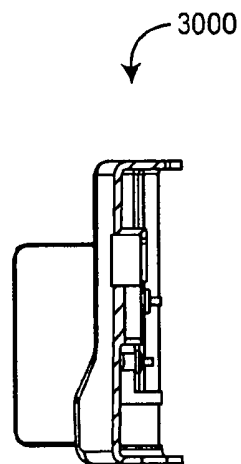


FIG. 30C



SECTION A-A

FIG. 30F

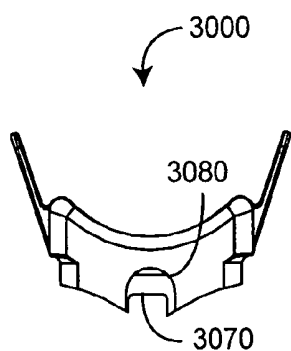


FIG. 30D

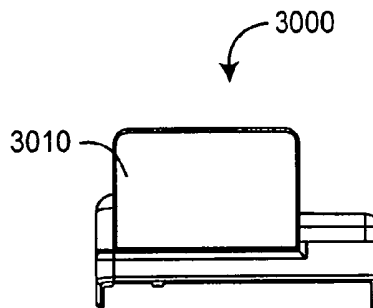


FIG. 30G

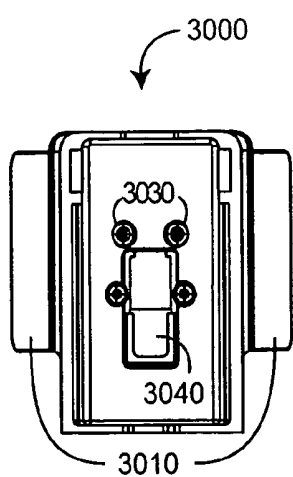
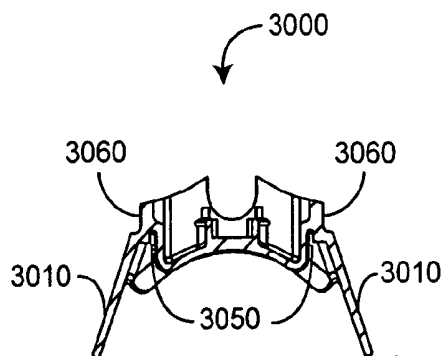


FIG. 30E



SECTION B-B

FIG. 30H

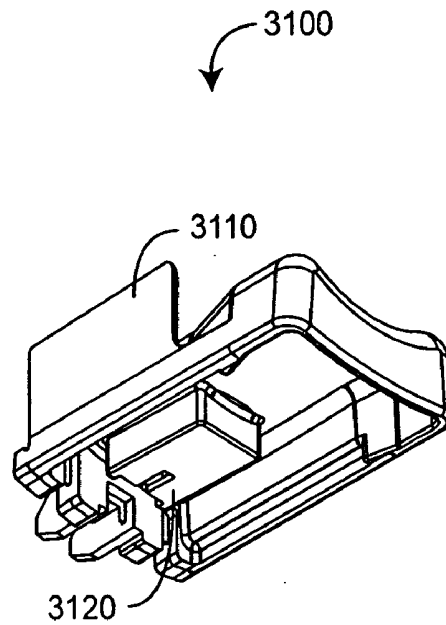


FIG. 31A

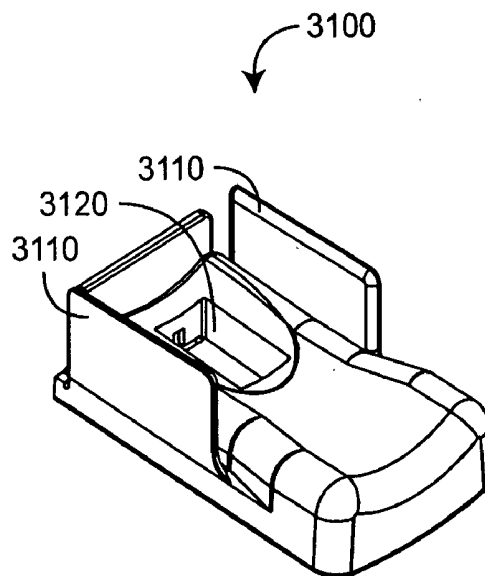


FIG. 31B

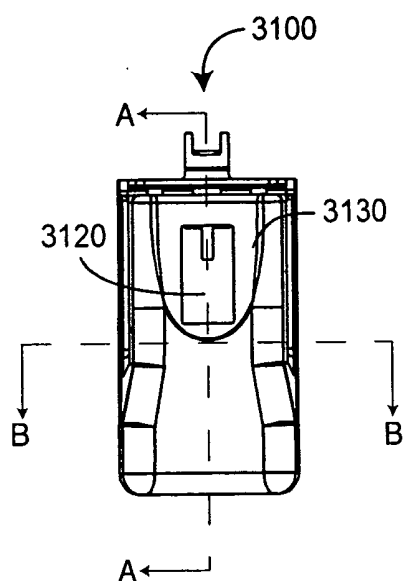
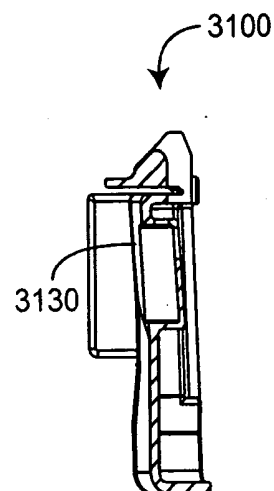


FIG. 31C



SECTION A-A

FIG. 31F

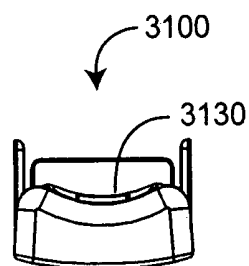


FIG. 31D

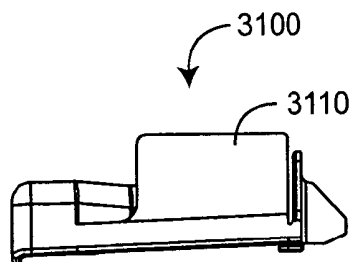


FIG. 31G

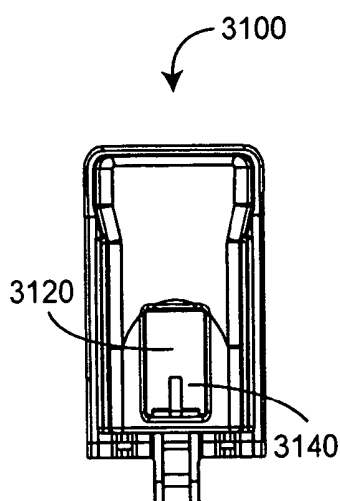
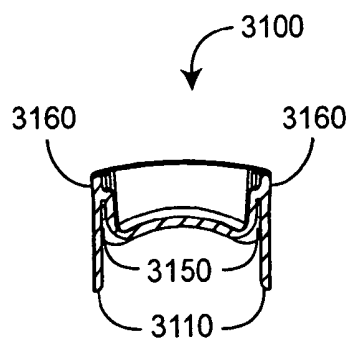


FIG. 31E



SECTION B-B

FIG. 31H



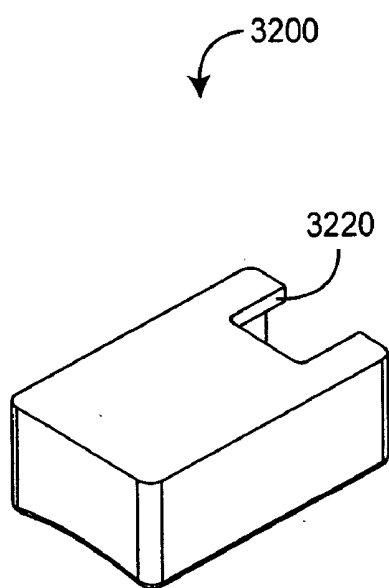


FIG. 32A

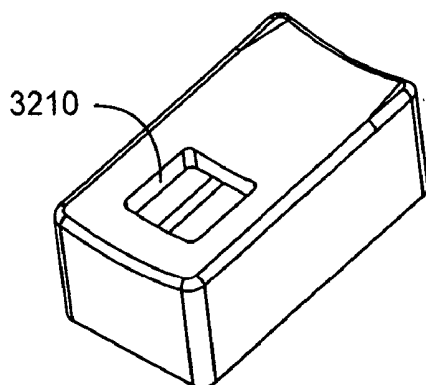


FIG. 32B

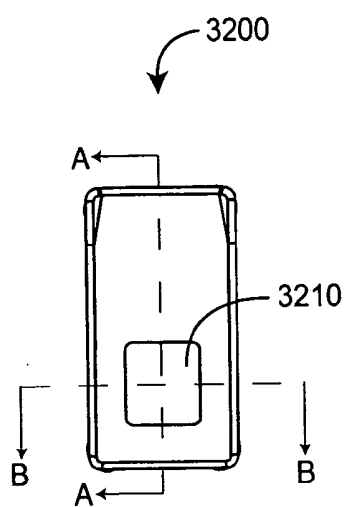
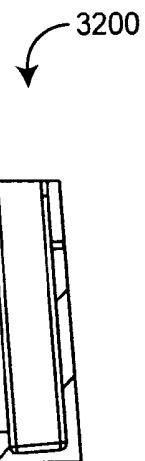


FIG. 32C



SECTION A-A

FIG. 32F

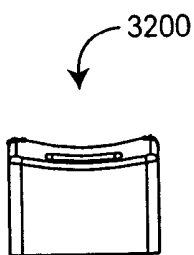


FIG. 32D

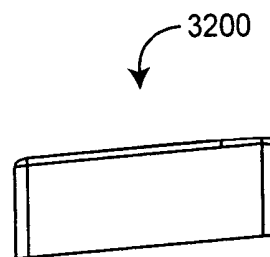


FIG. 32G

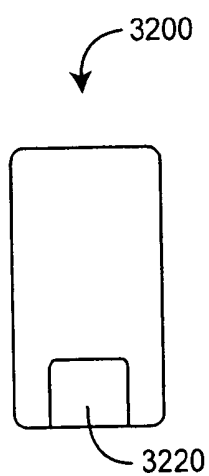
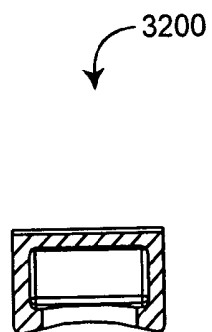


FIG. 32E



SECTION B-B

FIG. 32H

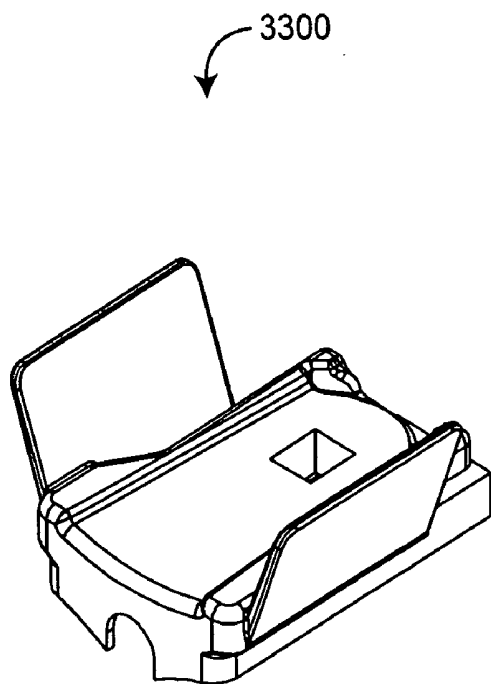


FIG. 33A

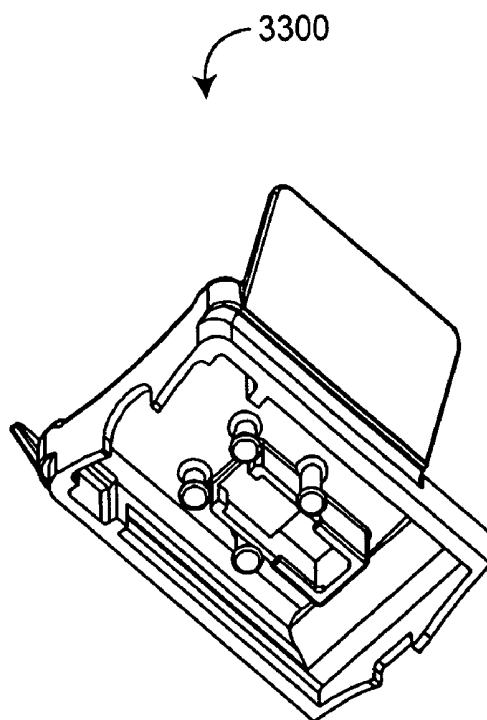


FIG. 33B

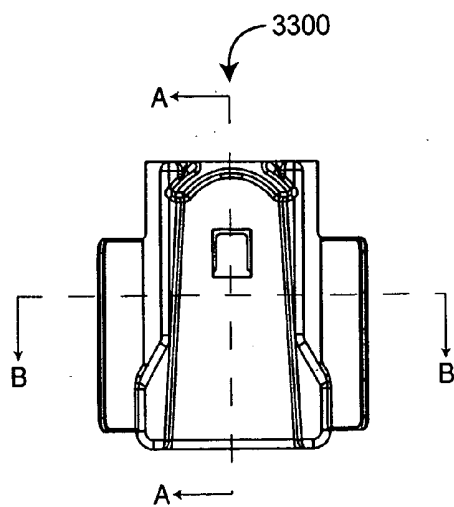


FIG. 33C

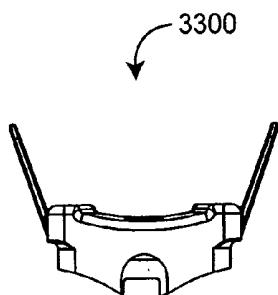


FIG. 33D

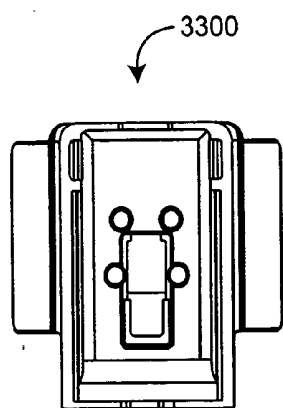
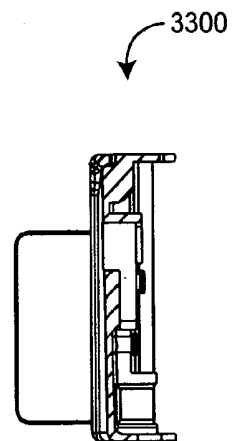


FIG. 33E



SECTION A-A

FIG. 33F

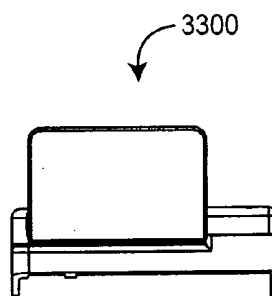
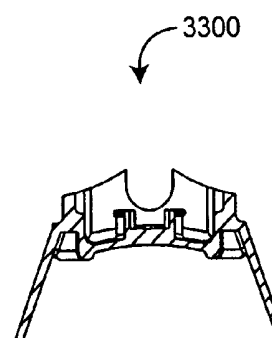


FIG. 33G



SECTION B-B

FIG. 33H

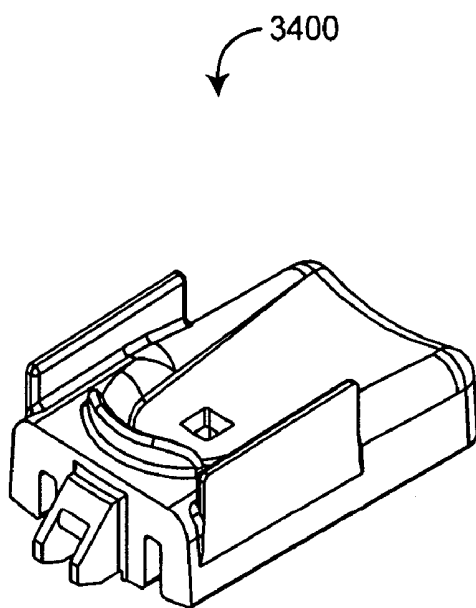


FIG. 34A

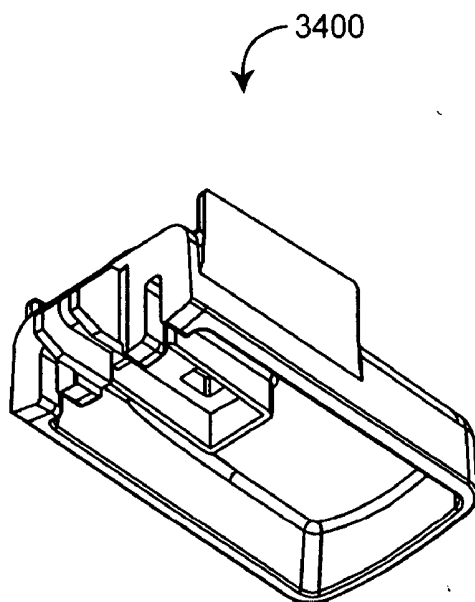


FIG. 34B

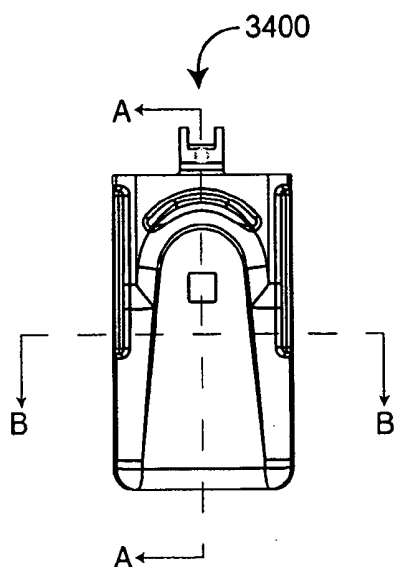


FIG. 34C

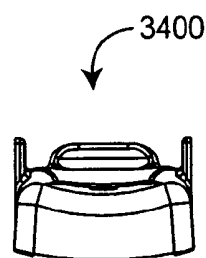


FIG. 34D

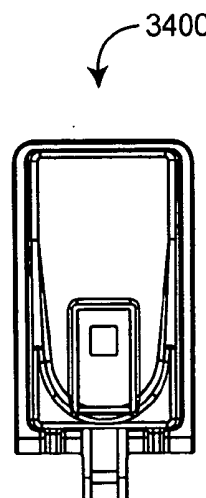
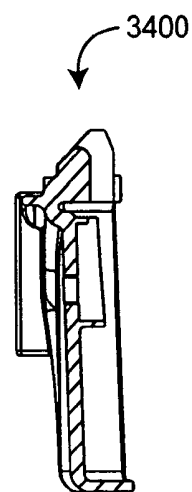


FIG. 34E



SECTION A-A

FIG. 34F

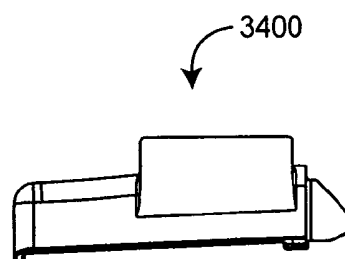
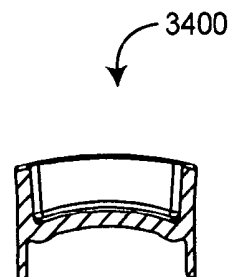


FIG. 34G



SECTION B-B

FIG. 34H

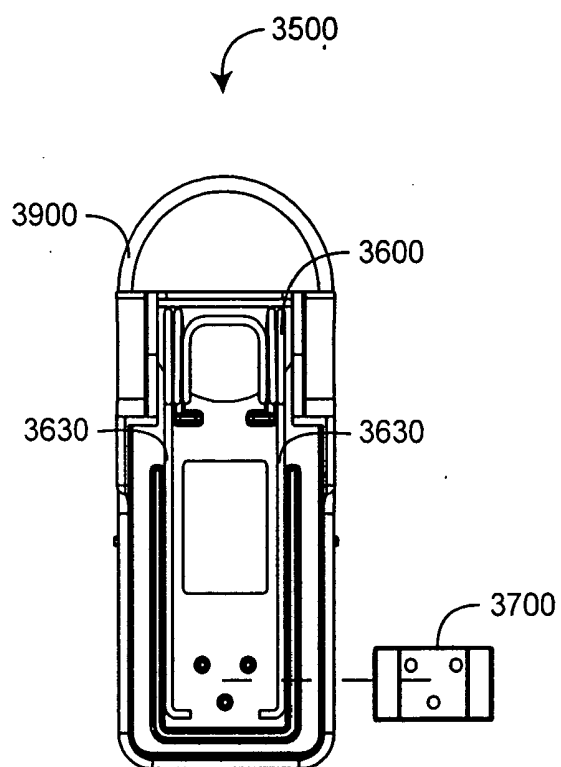


FIG. 35A

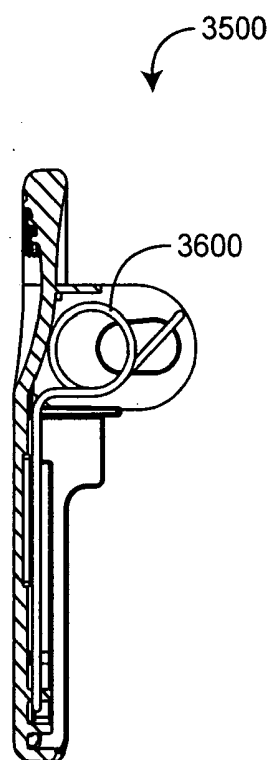


FIG. 35B

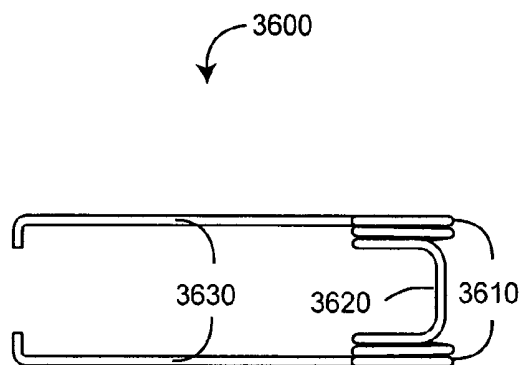


FIG. 36A

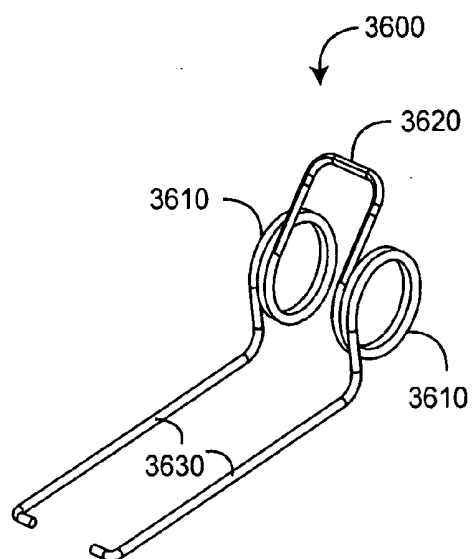


FIG. 36B

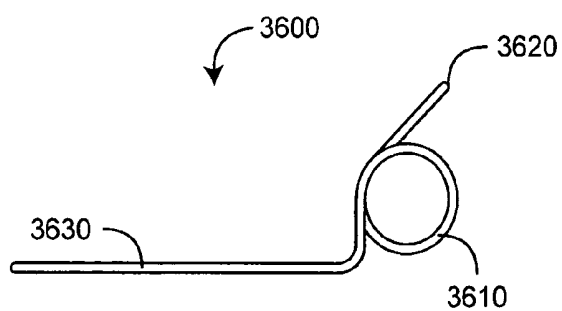


FIG. 36C



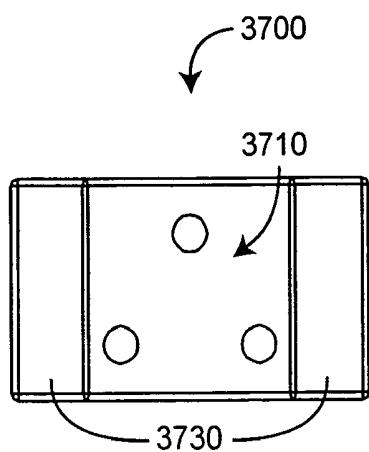


FIG. 37A

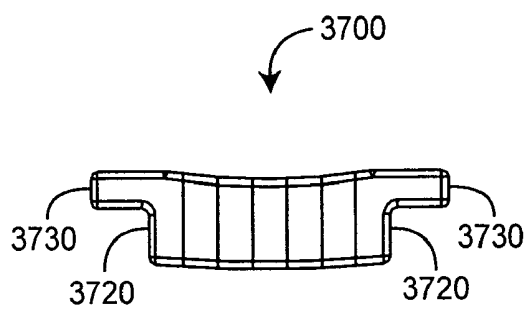


FIG. 37B

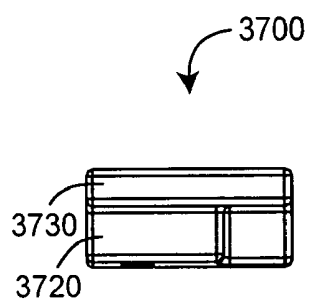


FIG. 37D

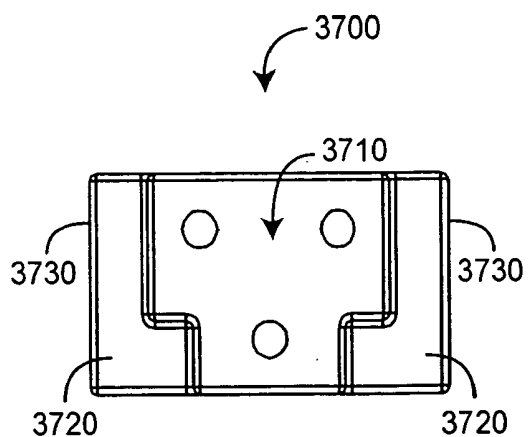


FIG. 37C

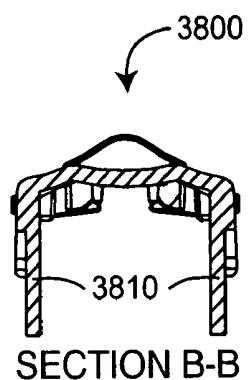


FIG. 38A

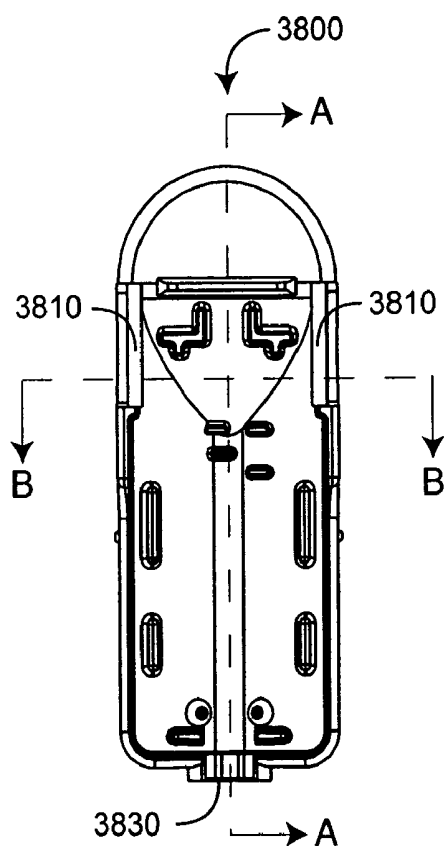


FIG. 38B

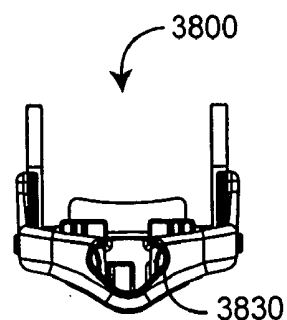
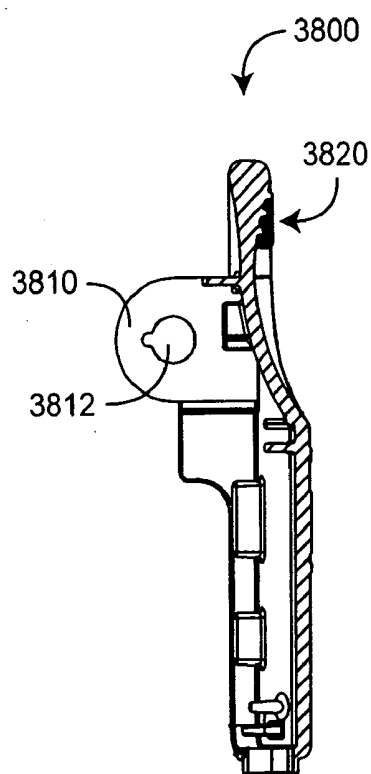


FIG. 38C



SECTION A-A  
FIG. 38D

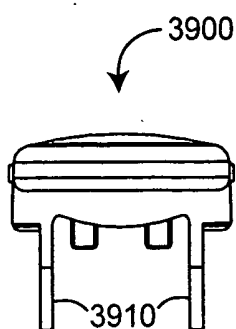


FIG. 39A

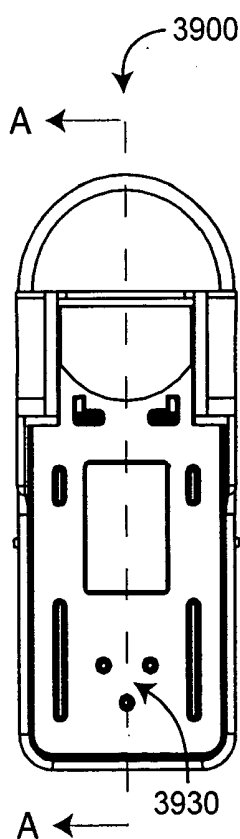


FIG. 39B

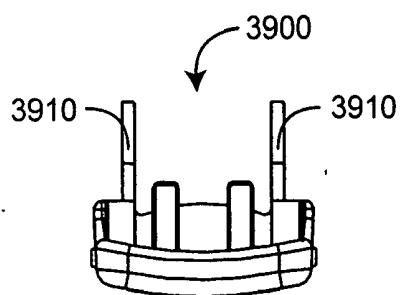
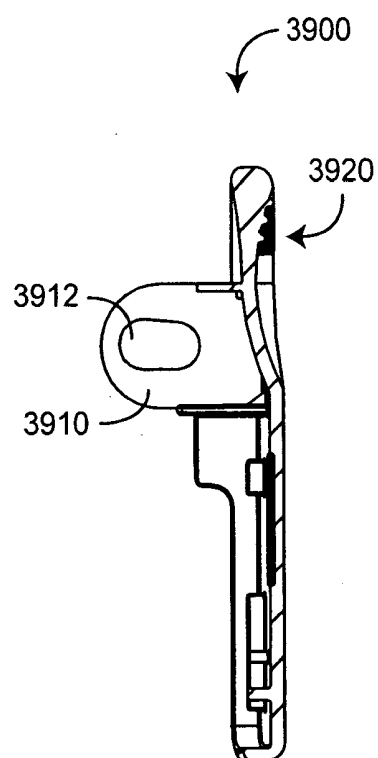


FIG. 39C



SECTION A-A  
FIG. 39D

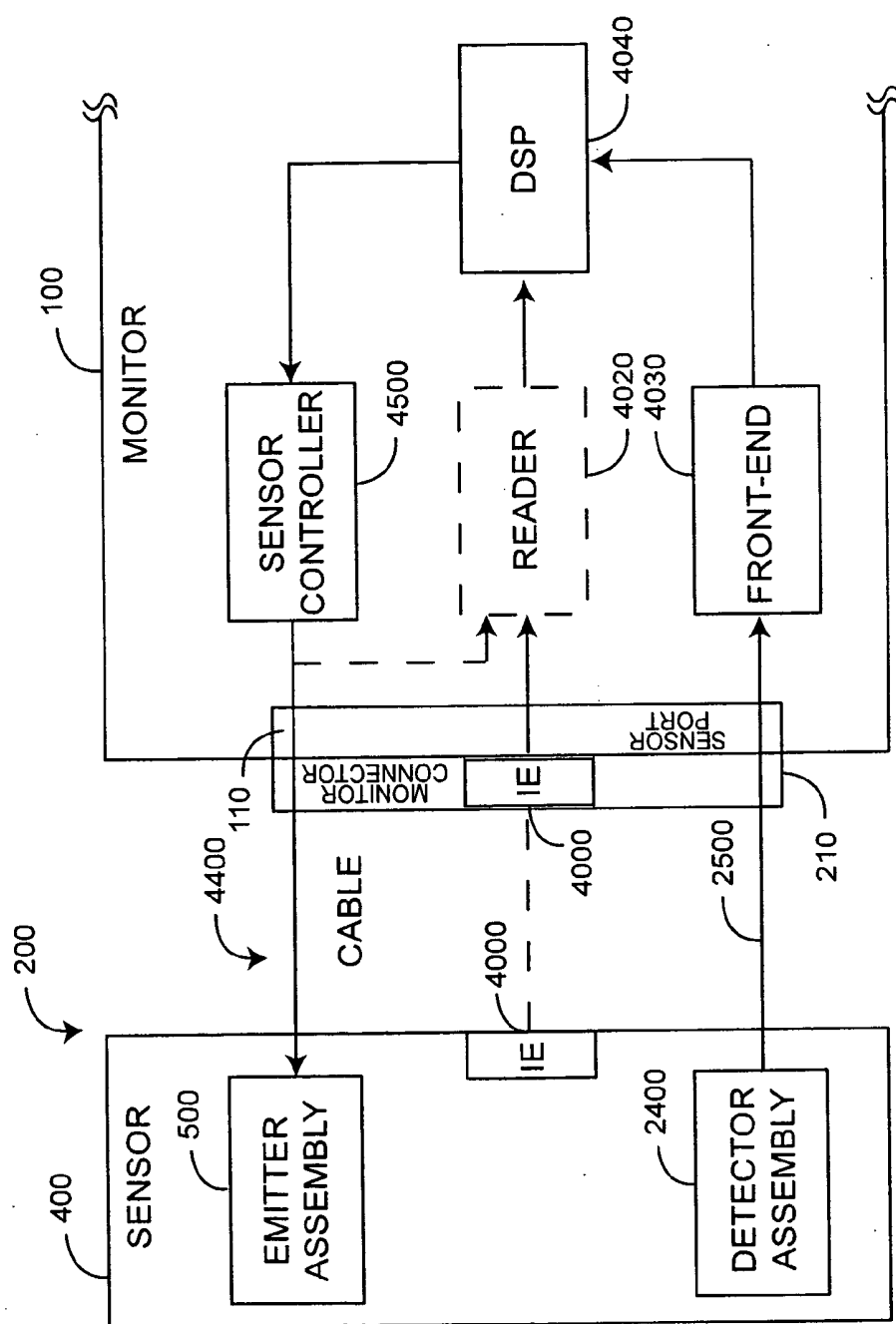


FIG. 40

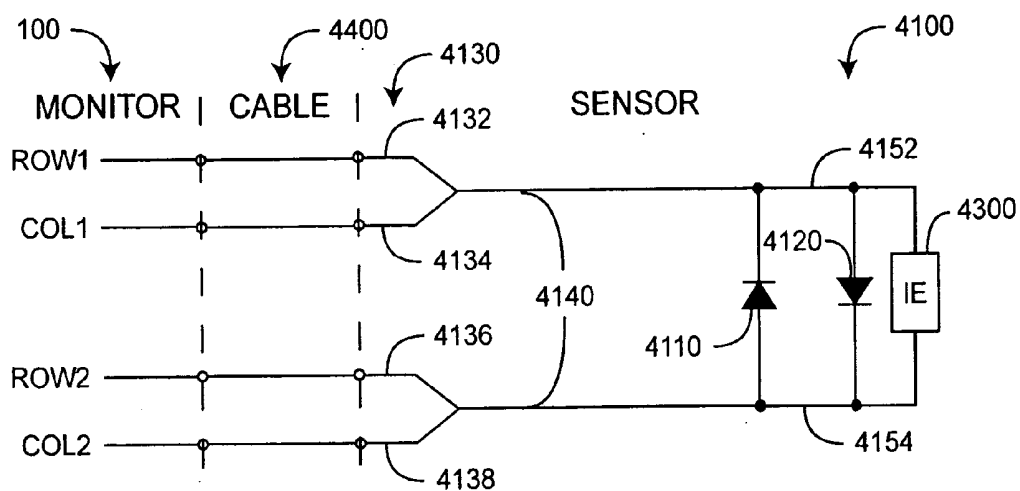


FIG. 41A

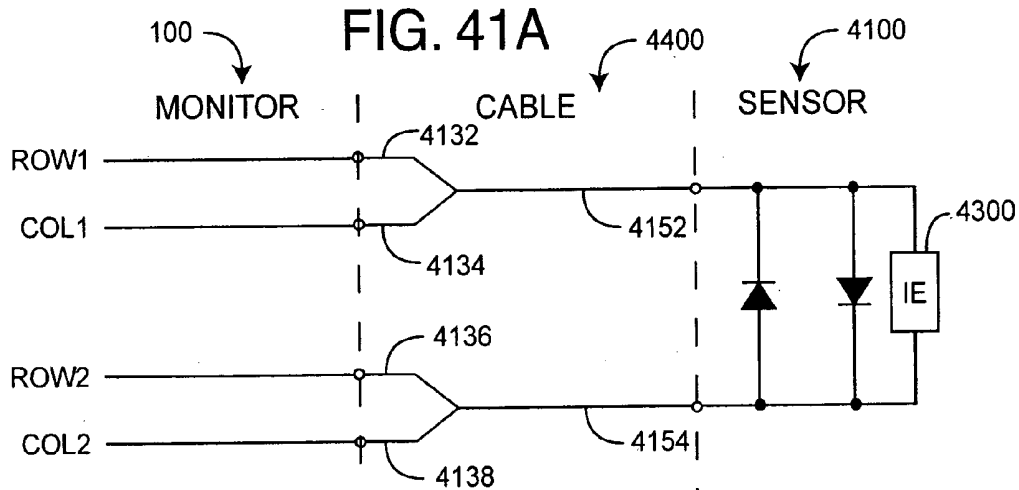


FIG. 41B

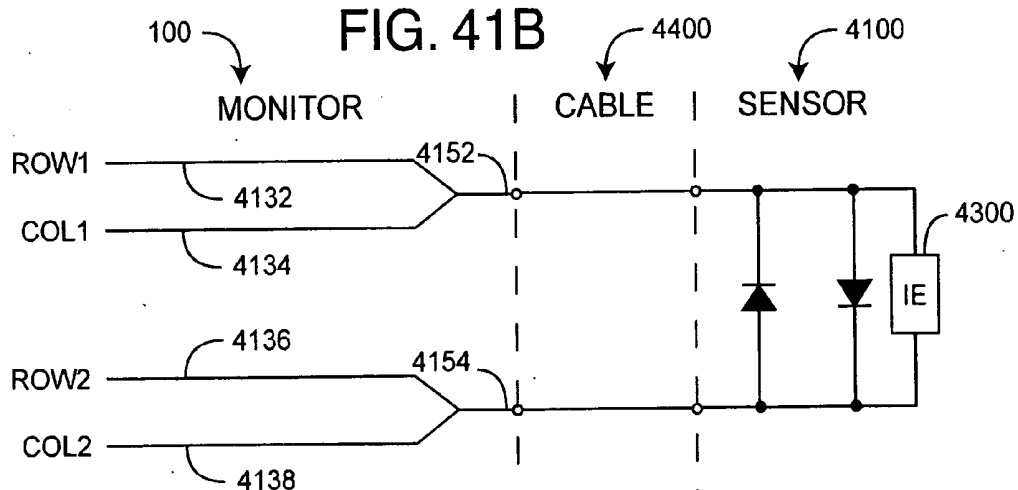
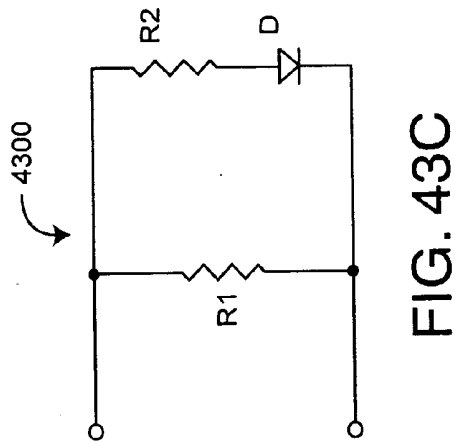
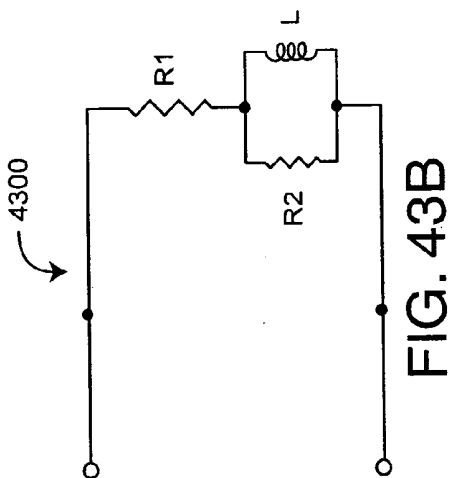
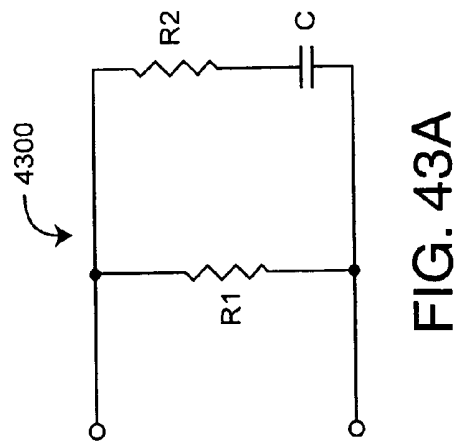
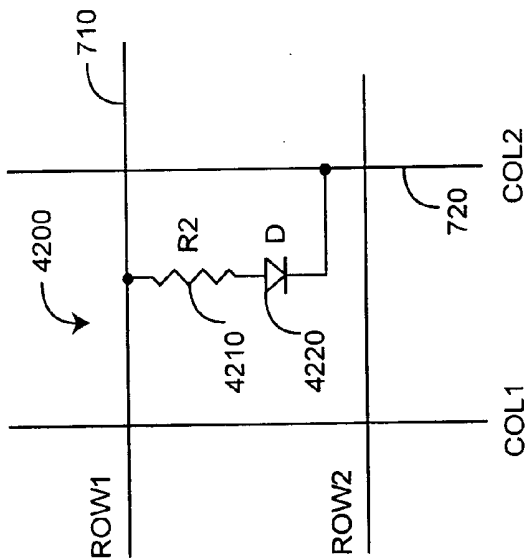


FIG. 41C



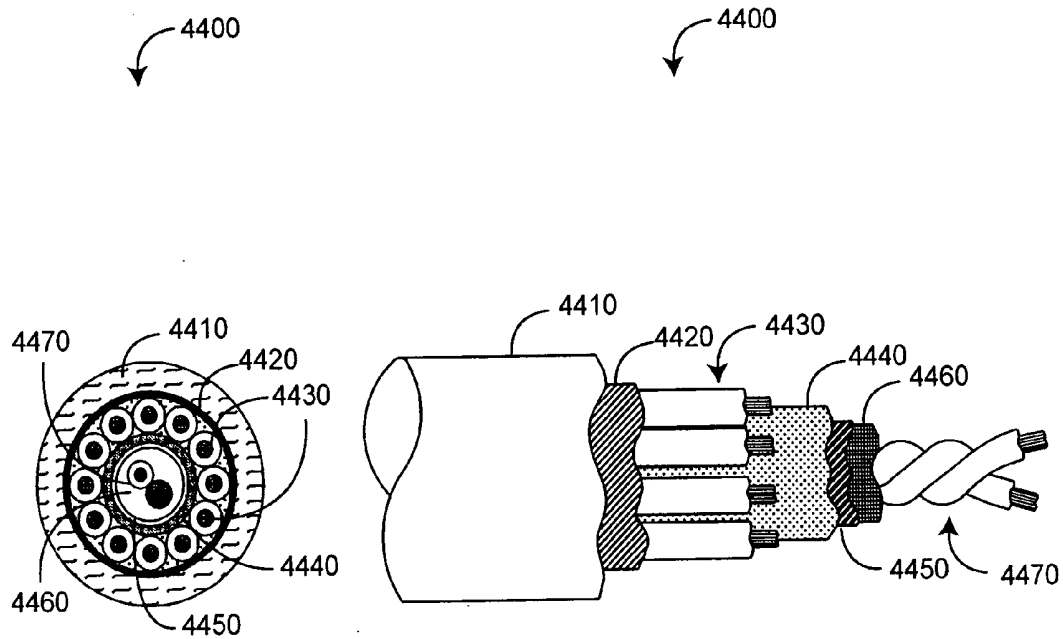


FIG. 44A

FIG. 44B

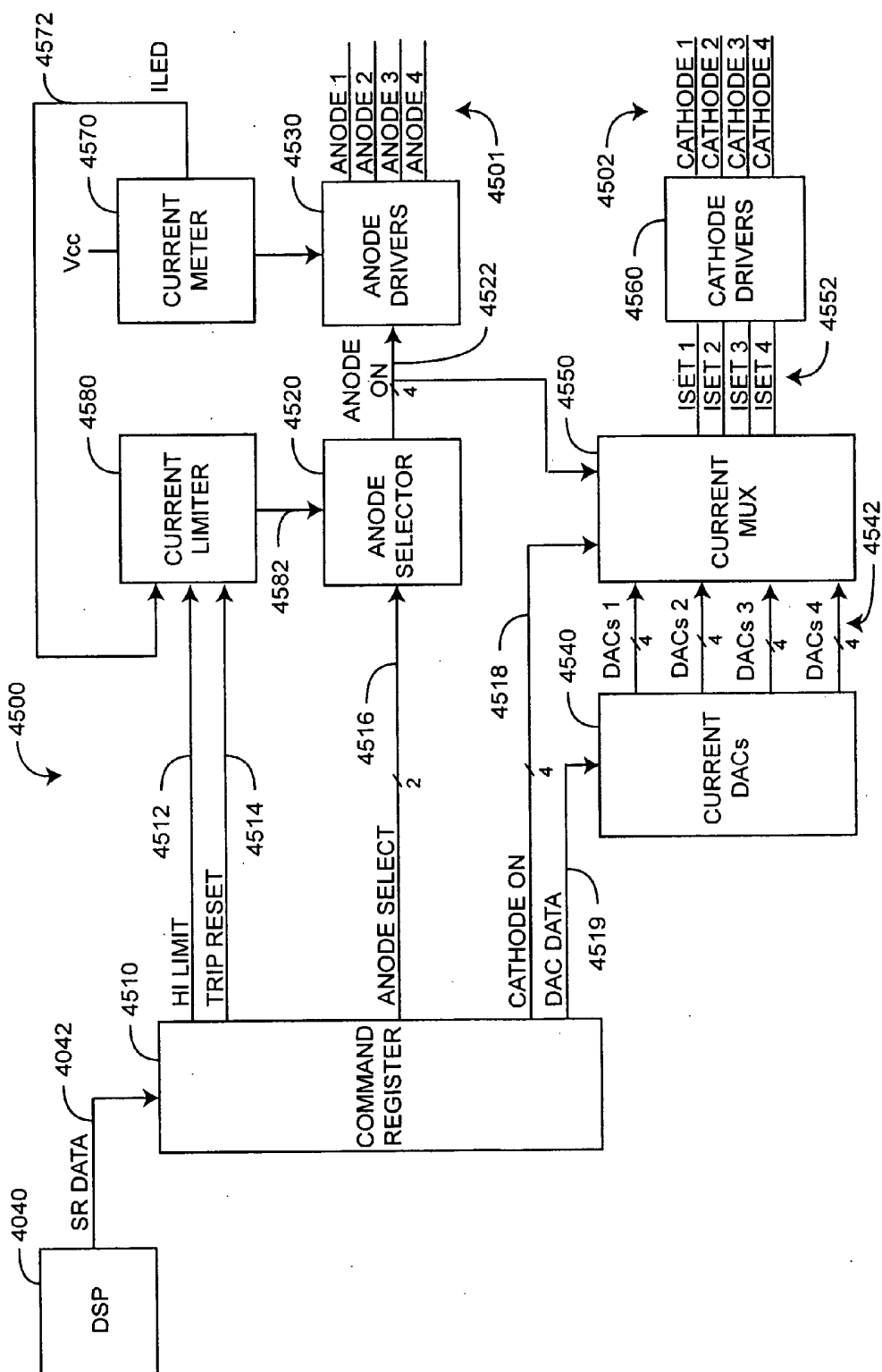
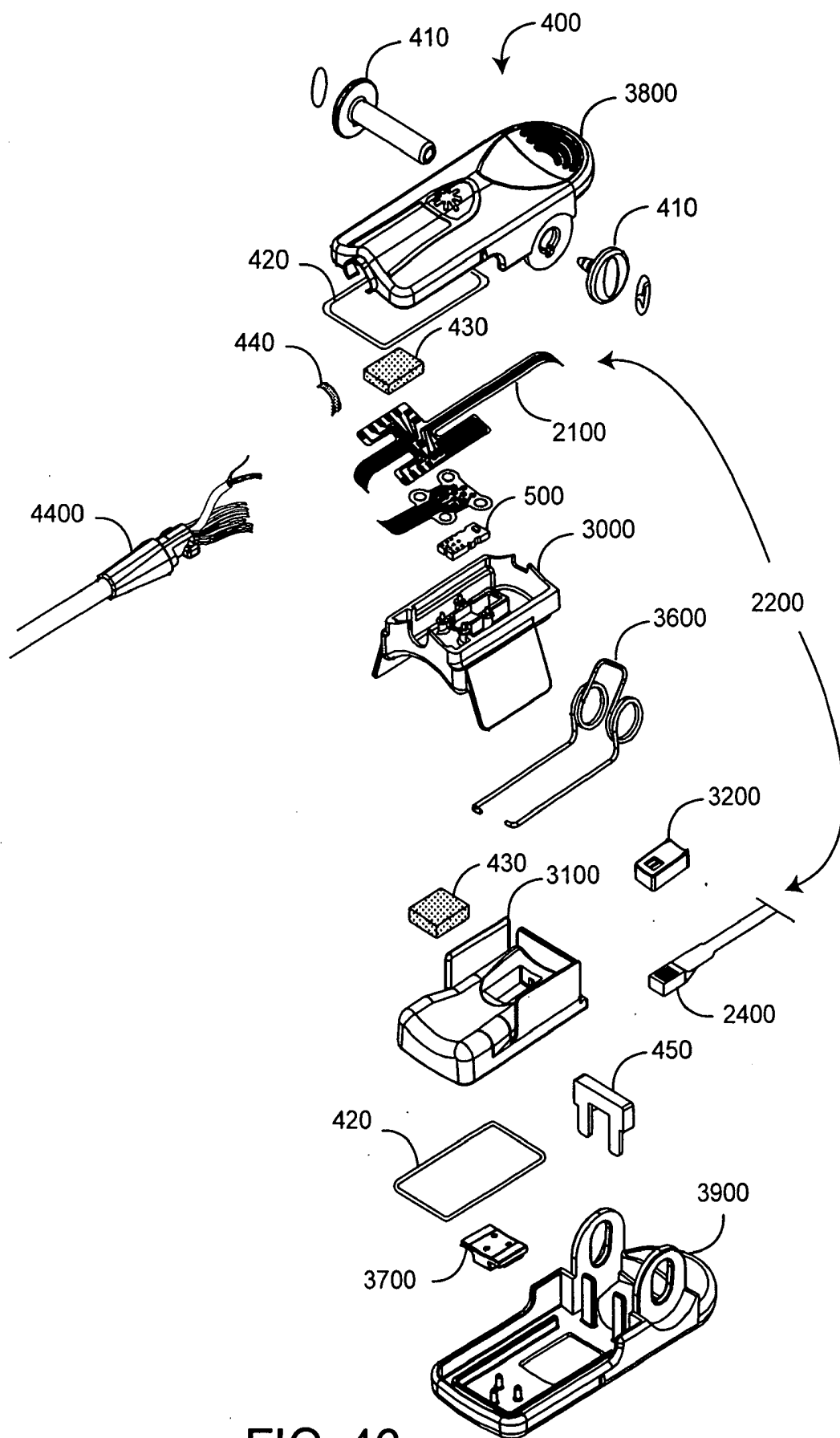


FIG. 45





# **MULTIPLE WAVELENGTH SENSOR SUBSTRATE**

## **PRIORITY CLAIM TO RELATED PROVISIONAL APPLICATIONS**

[0001] The present application claims priority benefit under 35 U.S.C. § 119(e) to U.S. Provisional Patent Application Ser. No. 60/657,596, filed Mar. 1, 2005, entitled “Multiple Wavelength Sensor,” No. 60/657,281, filed Mar. 1, 2005, entitled “Physiological Parameter Confidence Measure,” No. 60/657,268, filed Mar. 1, 2005, entitled “Configurable Physiological Measurement System,” and No. 60/657,759, filed Mar. 1, 2005, entitled “Noninvasive Multi-Parameter Patient Monitor.” The present application incorporates the foregoing disclosures herein by reference.

## **INCORPORATION BY REFERENCE OF COPENDING RELATED APPLICATIONS**

[0002] The present application is related to the following copending U.S. utility applications:

App. No.	Sr. No.	Filing Date	Title	Atty Dock.
1	11/####,###	Mar. 1, 2006	Multiple Wavelength Sensor Emitters	MLR.002A
2	11/####,###	Mar. 1, 2006	Multiple Wavelength Sensor Equalization	MLR.003A
3	11/####,###	Mar. 1, 2006	Multiple Wavelength Sensor Substrate	MLR.004A
4	11/####,###	Mar. 1, 2006	Multiple Wavelength Sensor Interconnect	MLR.005A
5	11/####,###	Mar. 1, 2006	Multiple Wavelength Sensor Attachment	MLR.006A
6	11/####,###	Mar. 1, 2006	Multiple Wavelength Sensor Drivers	MLR.009A
7	11/####,###	Mar. 1, 2006	Physiological Parameter Confidence Measure	MLR.010A
8	11/####,###	Mar. 1, 2006	Configurable Physiological Measurement System	MLR.011A
9	11/####,###	Mar. 1, 2006	Noninvasive Multi-Parameter Patient Monitor	MLR.012A
10	11/####,###	Mar. 1, 2006	Noninvasive Multi-Parameter Patient Monitor	MLR.013A
11	11/####,###	Mar. 1, 2006	Noninvasive Multi-Parameter Patient Monitor	MLR.014A

The present application incorporates the foregoing disclosures herein by reference.

## **BACKGROUND OF THE INVENTION**

[0003] Spectroscopy is a common technique for measuring the concentration of organic and some inorganic constituents of a solution. The theoretical basis of this technique is the Beer-Lambert law, which states that the concentration  $c_i$  of an absorbent in solution can be determined by the intensity of light transmitted through the solution, knowing the pathlength  $d_\lambda$ , the intensity of the incident light  $I_{0,\lambda}$ , and the extinction coefficient  $\epsilon_{i,\lambda}$  at a particular wavelength  $\lambda$ . In generalized form, the Beer-Lambert law is expressed as:

$$I_\lambda = I_{0,\lambda} e^{-d_\lambda \mu_{a,\lambda}} \quad (1)$$

$$\mu_{a,\lambda} = \sum_{i=1}^n \epsilon_{i,\lambda} \cdot c_i \quad (2)$$

where  $\mu_{a,\lambda}$  is the bulk absorption coefficient and represents the probability of absorption per unit length. The minimum number of discrete wavelengths that are required to solve EQS. 1-2 are the number of significant absorbers that are present in the solution.

[0004] A practical application of this technique is pulse oximetry, which utilizes a noninvasive sensor to measure oxygen saturation ( $\text{SpO}_2$ ) and pulse rate. In general, the sensor has light emitting diodes (LEDs) that transmit optical radiation of red and infrared wavelengths into a tissue site and a detector that responds to the intensity of the optical radiation after absorption (e.g., by transmission or transreflectance) by pulsatile arterial blood flowing within the tissue site. Based on this response, a processor determines measurements for  $\text{SpO}_2$ , pulse rate, and can output representative plethysmographic waveforms. Thus, “pulse oximetry” as used herein encompasses its broad ordinary meaning known to one of skill in the art, which includes at least those noninvasive procedures for measuring parameters of circulating blood through spectroscopy. Moreover, “plethysmograph” as used herein (commonly referred to as “photoplethysmograph”), encompasses its broad ordinary meaning known to one of skill in the art, which includes at least data representative of a change in the absorption of particular wavelengths of light as a function of the changes in body tissue resulting from pulsing blood. Pulse oximeters capable of reading through motion induced noise are available from Masimo Corporation (“Masimo”) of Irvine, Calif. Moreover, portable and other oximeters capable of reading through motion induced noise are disclosed in at least U.S. Pat. Nos. 6,770,028, 6,658,276, 6,157,850, 6,002,952, 5,769,785, and 5,758,644, which are owned by Masimo and are incorporated by reference herein. Such reading through motion oximeters have gained rapid acceptance in a wide variety of medical applications, including surgical wards, intensive care and neonatal units, general wards, home care, physical training, and virtually all types of monitoring scenarios.

## **SUMMARY OF THE INVENTION**

[0005] There is a need to noninvasively measure multiple physiological parameters, other than, or in addition to, oxygen saturation and pulse rate. For example, hemoglobin species that are also significant under certain circumstances are carboxyhemoglobin and methemoglobin. Other blood parameters that may be measured to provide important clinical information are fractional oxygen saturation, total hemoglobin (Hbt), bilirubin and blood glucose, to name a few.

[0006] One aspect of a physiological sensor is emitters configured to transmit optical radiation having multiple wavelengths in response to corresponding drive currents. A thermal mass is disposed proximate the emitters so as to stabilize a bulk temperature for the emitters. A temperature

sensor is thermally coupled to the thermal mass. The temperature sensor provides a temperature sensor output responsive to the bulk temperature so that the wavelengths are determinable as a function of the drive currents and the bulk temperature.

[0007] Another aspect of a physiological sensor capable of emitting light into tissue and producing an output signal usable to determine one or more physiological parameters of a patient is a thermal mass. Light emitting sources are thermally coupled to the thermal mass. The sources have corresponding multiple operating wavelengths. A temperature sensor is thermally coupled to the thermal mass and is capable of determining a bulk temperature for the thermal mass, where the operating wavelengths are dependent on the bulk temperature. A detector is capable of detecting light emitted by the light emitting sources after tissue attenuation and is capable of outputting a signal usable to determine one or more physiological parameters of a patient based upon the operating wavelengths.

[0008] A further aspect of a physiological sensor adapted to determine a physiological parameter using light emitting sources with emission wavelengths affected by one or more dynamic operating parameters is to transmit optical radiation from the light emitting sources into body tissue. The optical radiation is detected after tissue attenuation. Multiple operating wavelengths of the light emitting sources are determined dependent on a bulk temperature of the light emitting sources. One or more physiological parameters of a patient are determined based upon the operating wavelengths.

[0009] An additional aspect of a physiological sensor is a sensor adapted to determine a physiological parameter using light emitting sources with emission wavelengths affected by one or more dynamic operating parameters. Optical radiation is transmitted from the light emitting sources into body tissue. The optical radiation is detected after tissue attenuation. An operating wavelength for each of the light emitting sources is indicated.

#### BRIEF DESCRIPTION OF THE DRAWINGS

[0010] FIG. 1 is a perspective view of a physiological measurement system utilizing a multiple wavelength sensor;

[0011] FIGS. 2A-C are perspective views of multiple wavelength sensor embodiments;

[0012] FIG. 3 is a general block diagram of a multiple wavelength sensor and sensor controller;

[0013] FIG. 4 is an exploded perspective view of a multiple wavelength sensor embodiment;

[0014] FIG. 5 is a general block diagram of an emitter assembly;

[0015] FIG. 6 is a perspective view of an emitter assembly embodiment;

[0016] FIG. 7 is a general block diagram of an emitter array;

[0017] FIG. 8 is a schematic diagram of an emitter array embodiment;

[0018] FIG. 9 is a general block diagram of equalization;

[0019] FIGS. 10A-D are block diagrams of various equalization embodiments;

[0020] FIGS. 11A-C are perspective views of an emitter assembly incorporating various equalization embodiments;

[0021] FIG. 12 is a general block diagram of an emitter substrate;

[0022] FIGS. 13-14 are top and detailed side views of an emitter substrate embodiment;

[0023] FIGS. 15-16 are top and bottom component layout views of an emitter substrate embodiment;

[0024] FIG. 17 is a schematic diagram of an emitter substrate embodiment;

[0025] FIG. 18 is a plan view of an inner layer of an emitter substrate embodiment;

[0026] FIG. 19 is a general block diagram of an interconnect assembly in relationship to other sensor assemblies;

[0027] FIG. 20 is a block diagram of an interconnect assembly embodiment;

[0028] FIG. 21 is a partially-exploded perspective view of a flex circuit assembly embodiment of an interconnect assembly;

[0029] FIG. 22 is a top plan view of a flex circuit;

[0030] FIG. 23 is an exploded perspective view of an emitter portion of a flex circuit assembly;

[0031] FIG. 24 is an exploded perspective view of a detector assembly embodiment;

[0032] FIGS. 25-26 are block diagrams of adjacent detector and stacked detector embodiments;

[0033] FIG. 27 is a block diagram of a finger clip embodiment of an attachment assembly;

[0034] FIG. 28 is a general block diagram of a detector pad;

[0035] FIGS. 29A-B are perspective views of detector pad embodiments;

[0036] FIGS. 30A-H are perspective bottom, perspective top, bottom, back, top, side cross sectional, side, and front cross sectional views of an emitter pad embodiment;

[0037] FIGS. 31A-H are perspective bottom, perspective top, top, back, bottom, side cross sectional, side, and front cross sectional views of a detector pad embodiment;

[0038] FIGS. 32A-H are perspective bottom, perspective top, top, back, bottom, side cross sectional, side, and front cross sectional views of a shoe box;

[0039] FIGS. 33A-H are perspective bottom, perspective top, top, back, bottom, side cross sectional, side, and front cross sectional views of a slim-finger emitter pad embodiment;

[0040] FIGS. 34A-H are perspective bottom, perspective top, top, back, bottom, side cross sectional, side, and front cross sectional views of a slim-finger detector pad embodiment;

[0041] FIGS. 35A-B are plan and cross sectional views, respectively, of a spring assembly embodiment;

[0042] FIGS. 36A-C are top, perspective and side views of a finger clip spring;

[0043] FIGS. 37A-D are top, back, bottom, and side views of a spring plate;

[0044] FIGS. 38A-D are front cross sectional, bottom, front and side cross sectional views of an emitter-pad shell;

[0045] FIGS. 39A-D are back, top, front and side cross sectional views of a detector-pad shell;

[0046] FIG. 40 is a general block diagram of a monitor and a sensor;

[0047] FIGS. 41A-C are schematic diagrams of grid drive embodiments for a sensor having back-to-back diodes and an information element;

[0048] FIGS. 42 is a schematic diagrams of a grid drive embodiment for an information element; FIGS. 43A-C are schematic diagrams for grid drive readable information elements;

[0049] FIGS. 44A-B are cross sectional and side cut away views of a sensor cable;

[0050] FIG. 45 is a block diagram of a sensor controller embodiment; and

[0051] FIG. 46 is a detailed exploded perspective view of a multiple wavelength sensor embodiment.

#### DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

##### Overview

[0052] In this application, reference is made to many blood parameters. Some references that have common shorthand designations are referenced through such shorthand designations. For example, as used herein, HbCO designates carboxyhemoglobin, HbMet designates methemoglobin, and Hbt designates total hemoglobin. Other shorthand designations such as COHb, MetHb, and tHb are also common in the art for these same constituents. These constituents are generally reported in terms of a percentage, often referred to as saturation, relative concentration or fractional saturation. Total hemoglobin is generally reported as a concentration in g/dL. The use of the particular shorthand designators presented in this application does not restrict the term to any particular manner in which the designated constituent is reported.

[0053] FIG. 1 illustrates a physiological measurement system 10 having a monitor 100 and a multiple wavelength sensor assembly 200 with enhanced measurement capabilities as compared with conventional pulse oximetry. The physiological measurement system 10 allows the monitoring of a person, including a patient. In particular, the multiple wavelength sensor assembly 200 allows the measurement of blood constituent and related parameters in addition to oxygen saturation and pulse rate. Alternatively, the multiple wavelength sensor assembly 200 allows the measurement of oxygen saturation and pulse rate with increased accuracy or robustness as compared with conventional pulse oximetry.

[0054] In one embodiment, the sensor assembly 200 is configured to plug into a monitor sensor port 110. Monitor keys 160 provide control over operating modes and alarms, to name a few. A display 170 provides readouts of measured parameters, such as oxygen saturation, pulse rate, HbCO and HbMet to name a few.

[0055] FIGS. 2A illustrates a multiple wavelength sensor assembly 200 having a sensor 400 adapted to attach to a tissue site, a sensor cable 4400 and a monitor connector 210. In one embodiment, the sensor 400 is incorporated into a reusable finger clip adapted to removably attach to, and transmit light through, a fingertip. The sensor cable 4400 and monitor connector 210 are integral to the sensor 400, as shown. In alternative embodiments, the sensor 400 may be configured separately from the cable 4400 and connector 210.

[0056] FIGS. 2B-C illustrate alternative sensor embodiments, including a sensor 401 (FIG. 2B) partially disposable and partially reusable (resposable) and utilizing an adhesive attachment mechanism. Also shown is a sensor 402 (FIG. 2C) being disposable and utilizing an adhesive attachment mechanism. In other embodiments, a sensor may be configured to attach to various tissue sites other than a finger, such as a foot or an ear. Also a sensor may be configured as a reflectance or transreflectance device that attaches to a forehead or other tissue surface.

[0057] FIG. 3 illustrates a sensor assembly 400 having an emitter assembly 500, a detector assembly 2400, an interconnect assembly 1900 and an attachment assembly 2700. The emitter assembly 500 responds to drive signals received from a sensor controller 4500 in the monitor 100 via the cable 4400 so as to transmit optical radiation having a plurality of wavelengths into a tissue site. The detector assembly 2400 provides a sensor signal to the monitor 100 via the cable 4400 in response to optical radiation received after attenuation by the tissue site. The interconnect assembly 1900 provides electrical communication between the cable 4400 and both the emitter assembly 500 and the detector assembly 2400. The attachment assembly 2700 attaches the emitter assembly 500 and detector assembly 2400 to a tissue site, as described above. The emitter assembly 500 is described in further detail with respect to FIG. 5, below. The interconnect assembly 1900 is described in further detail with respect to FIG. 19, below. The detector assembly 2400 is described in further detail with respect to FIG. 24, below. The attachment assembly 2700 is described in further detail with respect to FIG. 27, below.

[0058] FIG. 4 illustrates a sensor 400 embodiment that removably attaches to a fingertip. The sensor 400 houses a multiple wavelength emitter assembly 500 and corresponding detector assembly 2400. A flex circuit assembly 1900 mounts the emitter and detector assemblies 500, 2400 and interconnects them to a multi-wire sensor cable 4400. Advantageously, the sensor 400 is configured in several respects for both wearer comfort and parameter measurement performance. The flex circuit assembly 1900 is configured to mechanically decouple the cable 4400 wires from the emitter and detector assemblies 500, 2400 to reduce pad stiffness and wearer discomfort. The pads 3000, 3100 are mechanically decoupled from shells 3800, 3900 to increase flexibility and wearer comfort. A spring 3600 is configured in hinged shells 3800, 3900 so that the pivot point of the finger clip is well behind the fingertip, improving finger attachment and more evenly distributing the clip pressure along the finger.

[0059] As shown in FIG. 4, the detector pad 3100 is structured to properly position a fingertip in relationship to the detector assembly 2400. The pads have flaps that block

ambient light. The detector assembly **2400** is housed in an enclosure so as to reduce light piping from the emitter assembly to the detector assembly without passing through fingertip tissue. These and other features are described in detail below. Specifically, emitter assembly embodiments are described with respect to **FIGS. 5-18**. Interconnect assembly embodiments, including the flexible circuit assembly **1900**, are described with respect to **FIGS. 19-23**. Detector assembly embodiments are described with respect to **FIGS. 24-26**. Attachment assembly embodiments are described with respect to **FIGS. 27-39**.

#### Emitter Assembly

[0060] **FIG. 5** illustrates an emitter assembly **500** having an emitter array **700**, a substrate **1200** and equalization **900**. The emitter array **700** has multiple light emitting sources, each activated by addressing at least one row and at least one column of an electrical grid. The light emitting sources are capable of transmitting optical radiation having multiple wavelengths. The equalization **900** accounts for differences in tissue attenuation of the optical radiation across the multiple wavelengths so as to at least reduce wavelength-dependent variations in detected intensity. The substrate **1200** provides a physical mount for the emitter array and emitter-related equalization and a connection between the emitter array and the interconnection assembly. Advantageously, the substrate **1200** also provides a bulk temperature measurement so as to calculate the operating wavelengths for the light emitting sources. The emitter array **700** is described in further detail with respect to **FIG. 7**, below. Equalization is described in further detail with respect to **FIG. 9**, below. The substrate **1200** is described in further detail with respect to **FIG. 12**, below.

[0061] **FIG. 6** illustrates an emitter assembly **500** embodiment having an emitter array **700**, an encapsulant **600**, an optical filter **1100** and a substrate **1200**. Various aspects of the emitter assembly **500** are described with respect to **FIGS. 7-18**, below. The emitter array **700** emits optical radiation having multiple wavelengths of predetermined nominal values, advantageously allowing multiple parameter measurements. In particular, the emitter array **700** has multiple light emitting diodes (LEDs) **710** that are physically arranged and electrically connected in an electrical grid to facilitate drive control, equalization, and minimization of optical pathlength differences at particular wavelengths. The optical filter **1100** is advantageously configured to provide intensity equalization across a specific LED subset. The substrate **1200** is configured to provide a bulk temperature of the emitter array **700** so as to better determine LED operating wavelengths.

#### Emitter Array

[0062] **FIG. 7** illustrates an emitter array **700** having multiple light emitters (LE) **710** capable of emitting light **702** having multiple wavelengths into a tissue site **1**. Row drivers **4530** and column drivers **4560** are electrically connected to the light emitters **710** and activate one or more light emitters **710** by addressing at least one row **720** and at least one column **740** of an electrical grid. In one embodiment, the light emitters **710** each include a first contact **712** and a second contact **714**. The first contact **712** of a first subset **730** of light emitters is in communication with a first conductor **720** of the electrical grid. The second contact **714** of a second subset **750** of light emitters is in communication

with a second conductor **740**. Each subset comprises at least two light emitters, and at least one of the light emitters of the first and second subsets **730**, **750** are not in common. A detector **2400** is capable of detecting the emitted light **702** and outputting a sensor signal **2500** responsive to the emitted light **702** after attenuation by the tissue site **1**. As such, the sensor signal **2500** is indicative of at least one physiological parameter corresponding to the tissue site **1**, as described above.

[0063] **FIG. 8** illustrates an emitter array **700** having LEDs **801** connected within an electrical grid of  $n$  rows and  $m$  columns totaling  $n+m$  drive lines **4501**, **4502**, where  $n$  and  $m$  integers greater than one. The electrical grid advantageously minimizes the number of drive lines required to activate the LEDs **801** while preserving flexibility to selectively activate individual LEDs **801** in any sequence and multiple LEDs **801** simultaneously. The electrical grid also facilitates setting LED currents so as to control intensity at each wavelength, determining operating wavelengths and monitoring total grid current so as to limit power dissipation. The emitter array **700** is also physically configured in rows **810**. This physical organization facilitates clustering LEDs **801** according to wavelength so as to minimize pathlength variations and facilitates equalization of LED intensities.

[0064] As shown in **FIG. 8**, one embodiment of an emitter array **700** comprises up to sixteen LEDs **801** configured in an electrical grid of four rows **810** and four columns **820**. Each of the four row drive lines **4501** provide a common anode connection to four LEDs **801**, and each of the four column drive lines **4502** provide a common cathode connection to four LEDs **801**. Thus, the sixteen LEDs **801** are advantageously driven with only eight wires, including four anode drive lines **812** and four cathode drive lines **822**. This compares favorably to conventional common anode or cathode LED configurations, which require more drive lines. In a particular embodiment, the emitter array **700** is partially populated with eight LEDs having nominal wavelengths as shown in TABLE 1. Further, LEDs having wavelengths in the range of 610-630 nm are grouped together in the same row. The emitter array **700** is adapted to a physiological measurement system **10** (**FIG. 1**) for measuring  $H_bCO$  and/or  $METHb$  in addition to  $S_pO_2$  and pulse rate.

TABLE 1

LED	Nominal LED Wavelengths		
	$\lambda$	Row	Col
D1	630	1	1
D2	620	1	2
D3	610	1	3
D4		1	4
D5	700	2	1
D6	730	2	2
D7	660	2	3
D8	805	2	4
D9		3	1
D10		3	2
D11		3	3
D12	905	3	4
D13		4	1
D14		4	2
D15		4	3
D16		4	4

[0065] Also shown in FIG. 8, row drivers 4530 and column drivers 4560 located in the monitor 100 selectively activate the LEDs 801. In particular, row and column drivers 4530, 4560 function together as switches to Vcc and current sinks, respectively, to activate LEDs and as switches to ground and Vcc, respectively, to deactivate LEDs. This push-pull drive configuration advantageously prevents parasitic current flow in deactivated LEDs. In a particular embodiment, only one row drive line 4501 is switched to Vcc at a time. One to four column drive lines 4502, however, can be simultaneously switched to a current sink so as to simultaneously activate multiple LEDs within a particular row. Activation of two or more LEDs of the same wavelength facilitates intensity equalization, as described with respect to FIGS. 9-11, below. LED drivers are described in further detail with respect to FIG. 45, below.

[0066] Although an emitter assembly is described above with respect to an array of light emitters each configured to transmit optical radiation centered around a nominal wavelength, in another embodiment, an emitter assembly advantageously utilizes one or more tunable broadband light sources, including the use of filters to select the wavelength, so as to minimize wavelength-dependent pathlength differences from emitter to detector. In yet another emitter assembly embodiment, optical radiation from multiple emitters each configured to transmit optical radiation centered around a nominal wavelength is funneled to a tissue site point so as to minimize wavelength-dependent pathlength differences. This funneling may be accomplished with fiber optics or mirrors, for example. In further embodiments, the LEDs 801 can be configured with alternative orientations with correspondingly different drivers among various other configurations of LEDs, drivers and interconnecting conductors.

#### Equalization

[0067] FIG. 9 illustrate a physiological parameter measurement system 10 having a controller 4500, an emitter assembly 500, a detector assembly 2400 and a front-end 4030. The emitter assembly 500 is configured to transmit optical radiation having multiple wavelengths into the tissue site 1. The detector assembly 2400 is configured to generate a sensor signal 2500 responsive to the optical radiation after tissue attenuation. The front-end 4030 conditions the sensor signal 2500 prior to analog-to-digital conversion (ADC).

[0068] FIG. 9 also generally illustrates equalization 900 in a physiological measurement system 10 operating on a tissue site 1. Equalization encompasses features incorporated into the system 10 in order to provide a sensor signal 2500 that falls well within the dynamic range of the ADC across the entire spectrum of emitter wavelengths. In particular, equalization compensates for the imbalance in tissue light absorption due to Hb and HbO<sub>2</sub> 910. Specifically, these blood constituents attenuate red wavelengths greater than IR wavelengths. Ideally, equalization 900 balances this unequal attenuation. Equalization 900 can be introduced anywhere in the system 10 from the controller 4500 to front-end 4000 and can include compensatory attenuation versus wavelength, as shown, or compensatory amplification versus or both.

[0069] Equalization can be achieved to a limited extent by adjusting drive currents from the controller 4500 and front-end 4030 amplification accordingly to wavelength so as to compensate for tissue absorption characteristics. Signal demodulation constraints, however, limit the magnitude of

these adjustments. Advantageously, equalization 900 is also provided along the optical path from emitters 500 to detector 2400. Equalization embodiments are described in further detail with respect to FIGS. 10-11, below.

[0070] FIGS. 10A-D illustrate various equalization embodiments having an emitter array 700 adapted to transmit optical radiation into a tissue site 1 and a detector assembly 2400 adapted to generate a sensor signal 2500 responsive to the optical radiation after tissue attenuation. FIG. 10A illustrates an optical filter 1100 that attenuates at least a portion of the optical radiation before it is transmitted into a tissue site 1. In particular, the optical filter 1100 attenuates at least a portion of the IR wavelength spectrum of the optical radiation so as to approximate an equalization curve 900 (FIG. 9). FIG. 10B illustrates an optical filter 1100 that attenuates at least a portion of the optical radiation after it is attenuated by a tissue site 1, where the optical filter 1100 approximates an equalization curve 900 (FIG. 9).

[0071] FIG. 10C illustrates an emitter array 700 where at least a portion of the emitter array generates one or more wavelengths from multiple light emitters 710 of the same wavelength. In particular, the same-wavelength light emitters 710 boost at least a portion of the red wavelength spectrum so as to approximately equalize the attenuation curves 910 (FIG. 9). FIG. 10D illustrates a detector assembly 2400 having multiple detectors 2610, 2620 selected so as to equalize the attenuation curves 910 (FIG. 9). To a limited extent, optical equalization can also be achieved by selection of particular emitter array 700 and detector 2400 components, e.g. LEDs having higher output intensities or detectors having higher sensitivities at red wavelengths. Although equalization embodiments are described above with respect to red and IR wavelengths, these equalization embodiments can be applied to equalize tissue characteristics across any portion of the optical spectrum.

[0072] FIGS. 11A-C illustrates an optical filter 1100 for an emitter assembly 500 that advantageously provides optical equalization, as described above. LEDs within the emitter array 700 may be grouped according to output intensity or wavelength or both. Such a grouping facilitates equalization of LED intensity across the array. In particular, relatively low tissue absorption and/or relatively high output intensity LEDs can be grouped together under a relatively high attenuation optical filter. Likewise, relatively low tissue absorption and/or relatively low output intensity LEDs can be grouped together without an optical filter or under a relatively low or negligible attenuation optical filter. Further, high tissue absorption and/or low intensity LEDs can be grouped within the same row with one or more LEDs of the same wavelength being simultaneously activated, as described with respect to FIG. 10C, above. In general, there can be any number of LED groups and any number of LEDs within a group. There can also be any number of optical filters corresponding to the groups having a range of attenuation, including no optical filter and/or a "clear" filter having negligible attenuation.

[0073] As shown in FIGS. 11A-C, a filtering media may be advantageously added to an encapsulant that functions both as a cover to protect LEDs and bonding wires and as an optical filter 1100. In one embodiment, a filtering media 1100 encapsulates a select group of LEDs and a clear media 600 (FIG. 6) encapsulates the entire array 700 and the

filtering media **1000** (FIG. 6). In a particular embodiment, corresponding to TABLE 1, above, five LEDs nominally emitting at 660-905 nm are encapsulated with both a filtering media **1100** and an overlying clear media **600** (FIG. 6), i.e. attenuated. In a particular embodiment, the filtering media **1100** is a 40:1 mixture of a clear encapsulant (EPO-TEK OG147-7) and an opaque encapsulate (EPO-TEK OG147) both available from Epoxy Technology, Inc., Billerica, Mass. Three LEDs nominally emitting at 610-630 nm are only encapsulated with the clear media **600** (FIG. 6), i.e. unattenuated. In alternative embodiments, individual LEDs may be singly or multiply encapsulated according to tissue absorption and/or output intensity. In other alternative embodiments, filtering media may be separately attachable optical filters or a combination of encapsulants and separately attachable optical filters. In a particular embodiment, the emitter assembly **500** has one or more notches along each side proximate the component end **1305** (FIG. 13) for retaining one or more clip-on optical filters.

#### Substrate

[0074] FIG. 12 illustrates light emitters **710** configured to transmit optical radiation **1201** having multiple wavelengths in response to corresponding drive currents **1210**. A thermal mass **1220** is disposed proximate the emitters **710** so as to stabilize a bulk temperature **1202** for the emitters. A temperature sensor **1230** is thermally coupled to the thermal mass **1220**, wherein the temperature sensor **1230** provides a temperature sensor output **1232** responsive to the bulk temperature **1202** so that the wavelengths are determinable as a function of the drive currents **1210** and the bulk temperature **1202**.

[0075] In one embodiment, an operating wavelength  $\lambda_a$  of each light emitter **710** is determined according to EQ. 3

$$\lambda_a = f(T_b, I_{\text{drive}}, \Sigma I_{\text{drive}}) \quad (3)$$

where  $T_b$  is the bulk temperature,  $I_{\text{drive}}$  is the drive current for a particular light emitter, as determined by the sensor controller **4500** (FIG. 45), described below, and  $\Sigma I_{\text{drive}}$  is the total drive current for all light emitters. In another embodiment, temperature sensors are configured to measure the temperature of each light emitter **710** and an operating wavelength  $\lambda_a$  of each light emitter **710** is determined according to EQ. 4

$$\lambda_a = f(T_a, I_{\text{drive}}, \Sigma I_{\text{drive}}) \quad (4)$$

where  $T_a$  is the temperature of a particular light emitter,  $I_{\text{drive}}$  is the drive current for that light emitter and  $\Sigma I_{\text{drive}}$  is the total drive current for all light emitters.

[0076] In yet another embodiment, an operating wavelength for each light emitter is determined by measuring the junction voltage for each light emitter **710**. In a further embodiment, the temperature of each light emitter **710** is controlled, such as by one or more Peltier cells coupled to each light emitter **710**, and an operating wavelength for each light emitter **710** is determined as a function of the resulting controlled temperature or temperatures. In other embodiments, the operating wavelength for each light emitter **710** is determined directly, for example by attaching a charge coupled device (CCD) to each light emitter or by attaching a fiberoptic to each light emitter and coupling the fiberoptics to a wavelength measuring device, to name a few.

[0077] FIGS. 13-18 illustrate one embodiment of a substrate **1200** configured to provide thermal conductivity

between an emitter array **700** (FIG. 8) and a thermistor **1540** (FIG. 16). In this manner, the resistance of the thermistor **1540** (FIG. 16) can be measured in order to determine the bulk temperature of LEDs **801** (FIG. 8) mounted on the substrate **1200**. The substrate **1200** is also configured with a relatively significant thermal mass, which stabilizes and normalizes the bulk temperature so that the thermistor measurement of bulk temperature is meaningful.

[0078] FIGS. 13-14 illustrate a substrate **1200** having a component side **1301**, a solder side **1302**, a component end **1305** and a connector end **1306**. Alignment notches **1310** are disposed between the ends **1305**, **1306**. The substrate **1200** further has a component layer **1401**, inner layers **1402-1405** and a solder layer **1406**. The inner layers **1402-1405**, e.g. inner layer **1402** (FIG. 18), have substantial metallized areas **1411** that provide a thermal mass **1220** (FIG. 12) to stabilize a bulk temperature for the emitter array **700** (FIG. 12). The metallized areas **1411** also function to interconnect component pads **1510** and wire bond pads **1520** (FIG. 15) to the connector **1530**.

[0079] FIGS. 15-16 illustrate a substrate **1200** having component pads **1510** and wire bond pads **1520** at a component end **1305**. The component pads **1510** mount and electrically connect a first side (anode or cathode) of the LEDs **801** (FIG. 8) to the substrate **1200**. Wire bond pads **1520** electrically connect a second side (cathode or anode) of the LEDs **801** (FIG. 8) to the substrate **1200**. The connector end **1306** has a connector **1530** with connector pads **1532**, **1534** that mount and electrically connect the emitter assembly **500** (FIG. 23), including the substrate **1200**, to the flex circuit **2200** (FIG. 22). Substrate layers **1401-1406** (FIG. 14) have traces that electrically connect the component pads **1510** and wire bond pads **1520** to the connector **1532-1534**. A thermistor **1540** is mounted to thermistor pads **1550** at the component end **1305**, which are also electrically connected with traces to the connector **1530**. Plated thru holes electrically connect the connector pads **1532**, **1534** on the component and solder sides **1301**, **1302**, respectively.

[0080] FIG. 17 illustrates the electrical layout of a substrate **1200**. A portion of the LEDs **801**, including D1-D4 and D13-D16 have cathodes physically and electrically connected to component pads **1510** (FIG. 15) and corresponding anodes wire bonded to wire bond pads **1520**. Another portion of the LEDs **801**, including D5-D8 and D9-D12, have anodes physically and electrically connected to component pads **1510** (FIG. 15) and corresponding cathodes wire bonded to wire bond pads **1520**. The connector **1530** has row pinouts J21-J24, column pinouts J31-J34 and thermistor pinouts J40-J41 for the LEDs **801** and thermistor **1540**.

#### Interconnect Assembly

[0081] FIG. 19 illustrates an interconnect assembly **1900** that mounts the emitter assembly **500** and detector assembly **2400**, connects to the sensor cable **4400** and provides electrical communications between the cable and each of the emitter assembly **500** and detector assembly **2400**. In one embodiment, the interconnect assembly **1900** is incorporated with the attachment assembly **2700**, which holds the emitter and detector assemblies to a tissue site. An interconnect assembly embodiment utilizing a flexible (flex) circuit is described with respect to FIGS. 20-24, below.

[0082] FIG. 20 illustrates an interconnect assembly 1900 embodiment having a circuit substrate 2200, an emitter mount 2210, a detector mount 2220 and a cable connector 2230. The emitter mount 2210, detector mount 2220 and cable connector 2230 are disposed on the circuit substrate 2200. The emitter mount 2210 is adapted to mount an emitter assembly 500 having multiple emitters. The detector mount 2220 is adapted to mount a detector assembly 2400 having a detector. The cable connector 2230 is adapted to attach a sensor cable 4400. A first plurality of conductors 2040 disposed on the circuit substrate 2200 electrically interconnects the emitter mount 2210 and the cable connector 2230. A second plurality of conductors 2050 disposed on the circuit substrate 2200 electrically interconnects the detector mount 2220 and the cable connector 2230. A decoupling 2060 disposed proximate the cable connector 2230 substantially mechanically isolates the cable connector 2230 from both the emitter mount 2210 and the detector mount 2220 so that sensor cable stiffness is not translated to the emitter assembly 500 or the detector assembly 2400. A shield 2070 is adapted to fold over and shield one or more wires or pairs of wires of the sensor cable 4400.

[0083] FIG. 21 illustrates a flex circuit assembly 1900 having a flex circuit 2200, an emitter assembly 500 and a detector assembly 2400, which is configured to terminate the sensor end of a sensor cable 4400. The flex circuit assembly 1900 advantageously provides a structure that electrically connects yet mechanically isolates the sensor cable 4400, the emitter assembly 500 and the detector assembly 2400. As a result, the mechanical stiffness of the sensor cable 4400 is not translated to the sensor pads 3000, 3100 (FIGS. 30-31), allowing a comfortable finger attachment for the sensor 200 (FIG. 1). In particular, the emitter assembly 500 and detector assembly 2400 are mounted to opposite ends 2201, 2202 (FIG. 22) of an elongated flex circuit 2200. The sensor cable 4400 is mounted to a cable connector 2230 extending from a middle portion of the flex circuit 2200. Detector wires 4470 are shielded at the flex circuit junction by a fold-over conductive ink flap 2240, which is connected to a cable inner shield 4450. The flex circuit 2200 is described in further detail with respect to FIG. 22. The emitter portion of the flex circuit assembly 1900 is described in further detail with respect to FIG. 23. The detector assembly 2400 is described with respect to FIG. 24. The sensor cable 4400 is described with respect to FIGS. 44A-B, below.

[0084] FIG. 22 illustrates a sensor flex circuit 2200 having an emitter end 2201, a detector end 2202, an elongated interconnect 2204, 2206 between the ends 2201, 2202 and a cable connector 2230 extending from the interconnect 2204, 2206. The emitter end 2201 forms a "head" having emitter solder pads 2210 for attaching the emitter assembly 500 (FIG. 6) and mounting ears 2214 for attaching to the emitter pad 3000 (FIG. 30B), as described below. The detector end 2202 has detector solder pads for attaching the detector 2410 (FIG. 24). The interconnect 2204 between the emitter end 2201 and the cable connector 2230 forms a "neck," and the interconnect 2206 between the detector end 2202 and the cable connector 2230 forms a "tail." The cable connector 2230 forms "wings" that extend from the interconnect 2204, 2206 between the neck 2204 and tail 2206. A conductive ink flap 2240 connects to the cable inner shield 4450 (FIGS. 44A-B) and folds over to shield the detector wires 4470 (FIGS. 44A-B) soldered to the detector wire pads 2236. The outer wire pads 2238 connect to the remaining cable wires

4430 (FIGS. 44A-B). The flex circuit 2200 has top coverlay, top ink, inner coverlay, trace, trace base, bottom ink and bottom coverlay layers.

[0085] The flex circuit 2200 advantageously provides a connection between a multiple wire sensor cable 4400 (FIGS. 44A-B), a multiple wavelength emitter assembly 500 (FIG. 6) and a detector assembly 2400 (FIG. 24) without rendering the emitter and detector assemblies unwieldy and stiff. In particular, the wings 2230 provide a relatively large solder pad area 2232 that is narrowed at the neck 2204 and tail 2206 to mechanically isolate the cable 4400 (FIGS. 44A-B) from the remainder of the flex circuit 2200. Further, the neck 2206 is folded (see FIG. 4) for installation in the emitter pad 3000 (FIGS. 30A-H) and acts as a flexible spring to further mechanically isolate the cable 4400 (FIGS. 44A-B) from the emitter assembly 500 (FIG. 4). The tail 2206 provides an integrated connectivity path between the detector assembly 2400 (FIG. 24) mounted in the detector pad 3100 (FIGS. 31A-H) and the cable connector 2230 mounted in the opposite emitter pad 3000 (FIGS. 30A-H).

[0086] FIG. 23 illustrates the emitter portion of the flex circuit assembly 1900 (FIG. 21) having the emitter assembly 500. The emitter assembly connector 1530 is attached to the emitter end 2210 of the flex circuit 2200 (FIG. 22). In particular, reflow solder 2330 connects thru hole pads 1532, 1534 of the emitter assembly 500 to corresponding emitter pads 2310 of the flex circuit 2200 (FIG. 22).

[0087] FIG. 24 illustrates a detector assembly 2400 including a detector 2410, solder pads 2420, copper mesh tape 2430, an EMI shield 2440 and foil 2450. The detector 2410 is soldered 2460 chip side down to detector solder pads 2420 of the flex circuit 2200. The detector solder joint and detector ground pads 2420 are wrapped with the Kapton tape 2470. EMI shield tabs 2442 are folded onto the detector pads 2420 and soldered. The EMI shield walls are folded around the detector 2410 and the remaining tabs 2442 are soldered to the back of the EMI shield 2440. The copper mesh tape 2430 is cut to size and the shielded detector and flex circuit solder joint are wrapped with the copper mesh tape 2430. The foil 2450 is cut to size with a predetermined aperture 2452. The foil 2450 is wrapped around shielded detector with the foil side in and the aperture 2452 is aligned with the EMI shield grid 2444.

#### Detector Assembly

[0088] FIG. 25 illustrates an alternative detector assembly 2400 embodiment having adjacent detectors. Optical radiation having multiple wavelengths generated by emitters 700 is transmitted into a tissue site 1. Optical radiation at a first set of wavelengths is detected by a first detector 2510, such as, for example, a Si detector. Optical radiation at a second set of wavelengths is detected by a second detector 2520, such as, for example, a GaAs detector.

[0089] FIG. 26 illustrates another alternative detector assembly 2400 embodiment having stacked detectors coaxial along a light path. Optical radiation having multiple wavelengths generated by emitters 700 is transmitted into a tissue site 1. Optical radiation at a first set of wavelengths is detected by a first detector 2610. Optical radiation at a second set of wavelengths passes through the first detector 2610 and is detected by a second detector 2620. In a particular embodiment, a silicon (Si) detector and a gallium



arsenide (GaAs) detector are used. The Si detector is placed on top of the GaAs detector so that light must pass through the Si detector before reaching the GaAs detector. The Si detector can be placed directly on top of the GaAs detector or the Si and GaAs detector can be separated by some other medium, such as a transparent medium or air. In another particular embodiment, a germanium detector is used instead of the GaAs detector. Advantageously, the stacked detector arrangement minimizes error caused by pathlength differences as compared with the adjacent detector embodiment.

#### Finger Clip

[0090] FIG. 27 illustrates a finger clip embodiment 2700 of a physiological sensor attachment assembly. The finger clip 2700 is configured to removably attach an emitter assembly 500 (FIG. 6) and detector assembly 2400 (FIG. 24), interconnected by a flex circuit assembly 1900, to a fingertip. The finger clip 2700 has an emitter shell 3800, an emitter pad 3000, a detector pad 2800 and a detector shell 3900. The emitter shell 3800 and the detector shell 3900 are rotatably connected and urged together by the spring assembly 3500. The emitter pad 3000 is fixedly retained by the emitter shell. The emitter assembly 500 (FIG. 6) is mounted proximate the emitter pad 3000 and adapted to transmit optical radiation having a plurality of wavelengths into fingertip tissue. The detector pad 2800 is fixedly retained by the detector shell 3900. The detector assembly 3500 is mounted proximate the detector pad 2800 and adapted to receive the optical radiation after attenuation by fingertip tissue.

[0091] FIG. 28 illustrates a detector pad 2800 advantageously configured to position and comfortably maintain a fingertip relative to a detector assembly for accurate sensor measurements. In particular, the detector pad has fingertip positioning features including a guide 2810, a contour 2820 and a stop 2830. The guide 2810 is raised from the pad surface 2803 and narrows as the guide 2810 extends from a first end 2801 to a second end 2802 so as to increasingly conform to a fingertip as a fingertip is inserted along the pad surface 2803 from the first end 2801. The contour 2820 has an indentation defined along the pad surface 2803 generally shaped to conform to a fingertip positioned over a detector aperture 2840 located within the contour 2820. The stop 2830 is raised from the pad surface 2803 so as to block the end of a finger from inserting beyond the second end 2802. FIGS. 29A-B illustrate detector pad embodiments 3100, 3400 each having a guide 2810, a contour 2820 and a stop 2830, described in further detail with respect to FIGS. 31 and 34, respectively.

[0092] FIGS. 30A-H illustrate an emitter pad 3000 having emitter pad flaps 3010, an emitter window 3020, mounting pins 3030, an emitter assembly cavity 3040, isolation notches 3050, a flex circuit notch 3070 and a cable notch 3080. The emitter pad flaps 3010 overlap with detector pad flaps 3110 (FIGS. 31A-H) to block ambient light. The emitter window 3020 provides an optical path from the emitter array 700 (FIG. 8) to a tissue site. The mounting pins 3030 accommodate apertures in the flex circuit mounting ears 2214 (FIG. 22), and the cavity 3040 accommodates the emitter assembly 500 (FIG. 21). Isolation notches 3050 mechanically decouple the shell attachment 3060 from the remainder of the emitter pad 3000. The flex circuit notch

3070 accommodates the flex circuit tail 2206 (FIG. 22) routed to the detector pad 3100 (FIGS. 31A-H). The cable notch 3080 accommodates the sensor cable 4400 (FIGS. 44A-B). FIGS. 33A-H illustrate an alternative slim finger emitter pad 3300 embodiment.

[0093] FIGS. 31A-H illustrate a detector pad 3100 having detector pad flaps 3110, a shoe box cavity 3120 and isolation notches 3150. The detector pad flaps 3110 overlap with emitter pad flaps 3010 (FIGS. 30A-H), interleaving to block ambient light. The shoe box cavity 3120 accommodates a shoe box 3200 (FIG. 32A-H) described below. Isolation notches 3150 mechanically decouple the attachment points 3160 from the remainder of the detector pad 3100. FIGS. 34A-H illustrate an alternative slim finger detector pad 3400 embodiment.

[0094] FIGS. 32A-H illustrate a shoe box 3200 that accommodates the detector assembly 2400 (FIG. 24). A detector window 3210 provides an optical path from a tissue site to the detector 2410 (FIG. 24). A flex circuit notch 3220 accommodates the flex circuit tail 2206 (FIG. 22) routed from the emitter pad 3000 (FIGS. 30A-H). In one embodiment, the shoe box 3200 is colored black or other substantially light absorbing color and the emitter pad 3000 and detector pad 3100 are each colored white or other substantially light reflecting color.

[0095] FIGS. 35-37 illustrate a spring assembly 3500 having a spring 3600 configured to urge together an emitter shell 3800 (FIG. 46) and a detector shell 3900. The detector shell is rotatably connected to the emitter shell. The spring is disposed between the shells 3800, 3900 and adapted to create a pivot point along a finger gripped between the shells that is substantially behind the fingertip. This advantageously allows the shell hinge 3810, 3910 (FIGS. 38-39) to expand so as to distribute finger clip force along the inserted finger, comfortably keeping the fingertip in position over the detector without excessive force.

[0096] As shown in FIGS. 36A-C, the spring 3600 has coils 3610, an emitter shell leg 3620 and a detector shell leg 3630. The emitter shell leg 3620 presses against the emitter shell 3800 (FIGS. 38A-D) proximate a grip 3820 (FIGS. 38A-D). The detector shell legs 3630 extend along the detector shell 3900 (FIGS. 39A-D) to a spring plate 3700 (FIGS. 37A-D) attachment point. The coil 3610 is secured by hinge pins 410 (FIG. 46) and is configured to wind as the finger clip is opened, reducing its diameter and stress accordingly.

[0097] As shown in FIGS. 37A-D the spring plate 3700 has attachment apertures 3710, spring leg slots 3720, and a shelf 3730. The attachment apertures 3710 accept corresponding shell posts 3930 (FIGS. 39A-D) so as to secure the spring plate 3700 to the detector shell 3900 (FIG. 39A-D). Spring legs 3630 (FIG. 36A-C) are slidably anchored to the detector shell 3900 (FIG. 39A-D) by the shelf 3730, advantageously allowing the combination of spring 3600, shells 3800, 3900 and hinges 3810, 3910 to adjust to various finger sizes and shapes.

[0098] FIGS. 38-39 illustrate the emitter and detector shells 3800, 3900, respectively, having hinges 3810, 3910 and grips 3820, 3920. Hinge apertures 3812, 3912 accept hinge pins 410 (FIG. 46) so as to create a finger clip. The detector shell hinge aperture 3912 is elongated, allowing the hinge to expand to accommodate a finger.

## Monitor and Sensor

[0099] **FIG. 40** illustrates a monitor **100** and a corresponding sensor assembly **200**, as described generally with respect to **FIGS. 1-3**, above. The sensor assembly **200** has a sensor **400** and a sensor cable **4400**. The sensor **400** houses an emitter assembly **500** having emitters responsive to drivers within a sensor controller **4500** so as to transmit optical radiation into a tissue site. The sensor **400** also houses a detector assembly **2400** that provides a sensor signal **2500** responsive to the optical radiation after tissue attenuation. The sensor signal **2500** is filtered, amplified, sampled and digitized by the front-end **4030** and input to a DSP (digital signal processor) **4040**, which also commands the sensor controller **4500**. The sensor cable **4400** electrically communicates drive signals from the sensor controller **4500** to the emitter assembly **500** and a sensor signal **2500** from the detector assembly **2400** to the front-end **4030**. The sensor cable **4400** has a monitor connector **210** that plugs into a monitor sensor port **110**.

[0100] In one embodiment, the monitor **100** also has a reader **4020** capable of obtaining information from an information element (IE) in the sensor assembly **200** and transferring that information to the DSP **4040**, to another processor or component within the monitor **100**, or to an external component or device that is at least temporarily in communication with the monitor **100**. In an alternative embodiment, the reader function is incorporated within the DSP **4040**, utilizing one or more of DSP I/O, ADC, DAC features and corresponding processing routines, as examples.

[0101] In one embodiment, the monitor connector **210** houses the information element **4000**, which may be a memory device or other active or passive electrical component. In a particular embodiment, the information element **4000** is an EPROM, or other programmable memory, or an EEPROM, or other reprogrammable memory, or both. In an alternative embodiment, the information element **4000** is housed within the sensor **400**, or an information element **4000** is housed within both the monitor connector **4000** and the sensor **400**. In yet another embodiment, the emitter assembly **500** has an information element **4000**, which is read in response to one or more drive signals from the sensor controller **4500**, as described with respect to **FIGS. 41-43**, below. In a further embodiment, a memory information element is incorporated into the emitter array **700** (**FIG. 8**) and has characterization information relating to the LEDs **801** (**FIG. 8**). In one advantageous embodiment, trend data relating to slowly varying parameters, such as perfusion index, HbCO or METHb, to name a few, are stored in an IE memory device, such as EEPROM.

## Back-to-Back LEDs

[0102] **FIGS. 41-43** illustrate alternative sensor embodiments. A sensor controller **4500** configured to activate an emitter array **700** (**FIG. 7**) arranged in an electrical grid, is described with respect to **FIG. 7**, above. Advantageously, a sensor controller **4500** so configured is also capable of driving a conventional two-wavelength (red and IR) sensor **4100** having back-to-back LEDs **4110**, **4120** or an information element **4300** or both.

[0103] **FIG. 41A** illustrates a sensor **4100** having an electrical grid **4130** configured to activate light emitting

sources by addressing at least one row conductor and at least one column conductor. A first LED **4110** and a second LED **4120** are configured in a back-to-back arrangement so that a first contact **4152** is connected to a first LED **4110** cathode and a second LED **4120** anode and a second contact **4154** is connected to a first LED **4110** anode and a second LED **4120** cathode. The first contact **4152** is in communications with a first row conductor **4132** and a first column conductor **4134**. The second contact is in communications with a second row conductor **4136** and a second column conductor **4138**. The first LED **4110** is activated by addressing the first row conductor **4132** and the second column conductor **4138**. The second LED **4120** is activated by addressing the second row conductor **4136** and the first column conductor **4134**.

[0104] **FIG. 41B** illustrates a sensor cable **4400** embodying capable of communicating signals between a monitor **100** and a sensor **4100**. The cable **4400** has a first row input **4132**, a first column input **4134**, a second row input **4136** and a second column input **4138**. A first output **4152** combines the first row input **4132** and the first column input **4134**. A second output **4154** combines a second row input **4136** and second column input **4138**.

[0105] **FIG. 41C** illustrates a monitor **100** capable of communicating drive signals to a sensor **4100**. The monitor **4400** has a first row signal **4132**, a first column signal **4134**, a second row signal **4136** and a second column signal **4138**. A first output signal **4152** combines the first row signal **4132** and the first column signal **4134**. A second output signal **4154** combines a second row signal **4136** and second column signal **4138**.

## Information Elements

[0106] **FIGS. 42-43** illustrate information element **4200-4300** embodiments in communications with emitter array drivers configured to activate light emitters connected in an electrical grid. The information elements are configured to provide information as DC values, AC values or a combination of DC and AC values in response corresponding DC, AC or combination DC and AC electrical grid drive signals. **FIG. 42** illustrates information element embodiment **4200** advantageously driven directly by an electrical grid having rows **710** and columns **720**. In particular, the information element **4200** has a series connected resistor  $R_2$  **4210** and diode **4220** connected between a row line **710** and a column line **720** of an electrical grid. In this manner, the resistor  $R_2$  value can be read in a similar manner that LEDs **810** (**FIG. 8**) are activated. The diode **4220** is oriented, e.g. anode to row and cathode to column as the LEDs so as to prevent parasitic currents from unwanted activation of LEDs **810** (**FIG. 8**).

[0107] **FIGS. 43A-C** illustrate other embodiments where the value of  $R_1$  is read with a DC grid drive current and a corresponding grid output voltage level. In other particular embodiments, the combined values of  $R_1$ ,  $R_2$  and  $C$  or, alternatively,  $R_1$ ,  $R_2$  and  $L$  are read with a varying (AC) grid drive currents and a corresponding grid output voltage waveform. As one example, a step in grid drive current is used to determine component values from the time constant of a corresponding rise in grid voltage. As another example, a sinusoidal grid drive current is used to determine component values from the magnitude or phase or both of a corresponding sinusoidal grid voltage. The component values determined by DC or AC electrical grid drive currents

can represent sensor types, authorized suppliers or manufacturers, emitter wavelengths among others. Further, a diode D (FIG. 43C) can be used to provide one information element reading  $R_1$  at one drive level or polarity and another information element reading, combining  $R_1$  and  $R_2$ , at a second drive level or polarity, i.e. when the diode is forward biased.

[0108] Passive information element 4300 embodiments may include any of various combinations of resistors, capacitors or inductors connected in series and parallel, for example. Other information element 4300 embodiments connected to an electrical grid and read utilizing emitter array drivers incorporate other passive components, active components or memory components, alone or in combination, including transistor networks, PROMs, ROMs, EPROMs, EEPROMs, gate arrays and PLAs to name a few.

#### Sensor Cable

[0109] FIGS. 44A-B illustrate a sensor cable 4400 having an outer jacket 4410, an outer shield 4420, multiple outer wires 4430, an inner jacket 4440, an inner shield 4450, a conductive polymer 4460 and an inner twisted wire pair 4470. The outer wires 4430 are advantageously configured to compactly carry multiple drive signals to the emitter array 700 (FIG. 7). In one embodiment, there are twelve outer wires 4430 corresponding to four anode drive signals 4501 (FIG. 45), four cathode drive signals 4502 (FIG. 45), two thermistor pinouts 1450 (FIG. 15) and two spares. The inner twisted wire pair 4470 corresponds to the sensor signal 2500 (FIG. 25) and is extruded within the conductive polymer 4460 so as to reduce triboelectric noise. The shields 4420, 4450 and the twisted pair 4470 boost EMI and crosstalk immunity for the sensor signal 2500 (FIG. 25).

#### Controller

[0110] FIG. 45 illustrates a sensor controller 4500 located in the monitor 100 (FIG. 1) and configured to provide anode drive signals 4501 and cathode drive signals 4502 to the emitter array 700 (FIG. 7). The DSP (digital signal processor) 4040, which performs signal processing functions for the monitor, also provides commands 4042 to the sensor controller 4500. These commands determine drive signal 4501, 4502 levels and timing. The sensor controller 4500 has a command register 4510, an anode selector 4520, anode drivers 4530, current DACs (digital-to-analog converters) 4540, a current multiplexer 4550, cathode drivers 4560, a current meter 4570 and a current limiter 4580. The command register 4510 provides control signals responsive to the DSP commands 4042. In one embodiment, the command register 4510 is a shift register that loads serial command data 4042 from the DSP 4040 and synchronously sets output bits that select or enable various functions within the sensor controller 4500, as described below.

[0111] As shown in FIG. 45, the anode selector 4520 is responsive to anode select 4516 inputs from the command register 4510 that determine which emitter array row 810 (FIG. 8) is active. Accordingly, the anode selector 4520 sets one of the anode on 4522 outputs to the anode drivers 4530, which pulls up to Vcc one of the anode outputs 4501 to the emitter array 700 (FIG. 8).

[0112] Also shown in FIG. 45, the current DACs 4540 are responsive to command register data 4519 that determines the currents through each emitter array column 820 (FIG. 8). In one embodiment, there are four, 12-bit DACs associated with each emitter array column 820 (FIG. 8), sixteen

DACs in total. That is, there are four DAC outputs 4542 associated with each emitter array column 820 (FIG. 8) corresponding to the currents associated with each row 810 (FIG. 8) along that column 820 (FIG. 8). In a particular embodiment, all sixteen DACs 4540 are organized as a single shift register, and the command register 4510 serially clocks DAC data 4519 into the DACs 4540. A current multiplexer 4550 is responsive to cathode on 4518 inputs from the command register 4510 and anode on 4522 inputs from the anode selector 4520 so as to convert the appropriate DAC outputs 4542 to current set 4552 inputs to the cathode drivers 4560. The cathode drivers 4560 are responsive to the current set 4552 inputs to pull down to ground one to four of the cathode outputs 4502 to the emitter array 700 (FIG. 8).

[0113] The current meter 4570 outputs a current measure 4572 that indicates the total LED current driving the emitter array 700 (FIG. 8). The current limiter 4580 is responsive to the current measure 4572 and limits specified by the command register 4510 so as to prevent excessive power dissipation by the emitter array 700 (FIG. 8). The current limiter 4580 provides an enable 4582 output to the anode selector 4520. A Hi Limit 4512 input specifies the higher of two preset current limits. The current limiter 4580 latches the enable 4582 output in an off condition when the current limit is exceeded, disabling the anode selector 4520. A trip reset 4514 input resets the enable 4582 output to re-enable the anode selector 4520.

#### Sensor Assembly

[0114] As shown in FIG. 46, the sensor 400 has an emitter shell 3800, an emitter pad 3000, a flex circuit assembly 2200, a detector pad 3100 and a detector shell 3900. A sensor cable 4400 attaches to the flex circuit assembly 2200, which includes a flex circuit 2100, an emitter assembly 500 and a detector assembly 2400. The portion of the flex circuit assembly 2200 having the sensor cable 4400 attachment and emitter assembly 500 is housed by the emitter shell 3800 and emitter pad 3000. The portion of the flex circuit assembly 2200 having the detector assembly 2400 is housed by the detector shell 3900 and detector pad 3100. In particular, the detector assembly 2400 inserts into a shoe 3200, and the shoe 3200 inserts into the detector pad 3100. The emitter shell 3800 and detector shell 3900 are fastened by and rotate about hinge pins 410, which insert through coils of a spring 3600. The spring 3600 is held to the detector shell 3900 with a spring plate 3700. A finger stop 450 attaches to the detector shell. In one embodiment, a silicon adhesive 420 is used to attach the pads 3000, 3100 to the shells 3800, 3900, a silicon potting compound 430 is used to secure the emitter and detector assemblies 500, 2400 within the pads 3000, 3100, and a cyanoacrylic adhesive 440 secures the sensor cable 4400 to the emitter shell 3800.

[0115] A multiple wavelength sensor has been disclosed in detail in connection with various embodiments. These embodiments are disclosed by way of examples only and are not to limit the scope of the claims that follow. One of ordinary skill in art will appreciate many variations and modifications.

What is claimed is:

1. A physiological sensor comprising:

a plurality of emitters configured to transmit optical radiation having a plurality of wavelengths in response to a corresponding plurality of drive currents;

a thermal mass disposed proximate the emitters so as to stabilize a bulk temperature for the emitters; and

a temperature sensor thermally coupled to the thermal mass,

wherein the temperature sensor provides a temperature sensor output responsive to the bulk temperature so that the wavelengths are determinable as a function of the drive currents and the bulk temperature.

2. The physiological sensor according to claim 1 further comprising a substrate having a first side and a second side,

wherein the emitters are mounted to the first side, and

wherein the temperature sensor is mounted to the second side.

3. The physiological sensor according to claim 2 wherein the temperature sensor is a thermistor and the emitters are LEDs.

4. The physiological sensor according to claim 3:

wherein the thermal mass is a plurality of layers of the substrate, and

wherein each of the layers is substantially copper clad.

5. A physiological sensor capable of emitting light into tissue and producing an output signal usable to determine one or more physiological parameters of a patient, the physiological sensor comprising:

a thermal mass;

a plurality of light emitting sources thermally coupled to the thermal mass, the sources having a corresponding plurality of operating wavelengths;

a temperature sensor thermally coupled to the thermal mass and capable of determining a bulk temperature for the thermal mass, the operating wavelengths dependent on the bulk temperature; and

a detector capable of detecting light emitted by the light emitting sources after tissue attenuation, wherein the detector is capable of outputting a signal usable to determine one or more physiological parameters of a patient based upon the operating wavelengths.

6. The physiological sensor according to claim 5:

wherein the light emitting sources and the temperature sensor are disposed on a substrate, and

wherein the thermal mass is disposed within the substrate proximate the light emitting sources and the temperature sensor.

7. The physiological sensor according to claim 6 wherein the temperature sensor comprises a thermistor.

8. The physiological sensor according to claim 7 wherein the light emitting sources are disposed on a first side of the substrate and the temperature sensor is disposed on a second side of the substrate.

9. In a physiological sensor adapted to determine a physiological parameter using a plurality of light emitting sources with emission wavelengths affected by one or more dynamic operating parameters, a sensor method comprising:

transmitting optical radiation from the plurality of light emitting sources into body tissue;

detecting the optical radiation after tissue attenuation; and

determining a plurality of operating wavelengths of the light emitting sources dependent on a bulk temperature of the light emitting sources so that one or more physiological parameters of a patient can be determined based upon the operating wavelengths.

10. The physiological sensor method according to claim 9 wherein the determining step comprises stabilizing the bulk temperature for the light emitting sources.

11. The physiological sensor method according to claim 10 wherein the determining further comprises thermally coupling a thermistor to the light emitting sources so as to indicate the bulk temperature.

12. The physiological sensor method according to claim 11 further comprising disposing the thermistor proximate the light emitting sources.

13. In a physiological sensor adapted to determine a physiological parameter using a plurality of light emitting sources with emission wavelengths affected by one or more dynamic operating parameters, a sensor method comprising:

transmitting optical radiation from the plurality of light emitting sources into body tissue;

detecting the optical radiation after tissue attenuation; and

indicating an operating wavelength for each of the plurality of light emitting sources.

14. The physiological sensor method according to claim 13 wherein the indicating step comprises measuring a bulk temperature for the light emitting sources.

15. The physiological sensor method according to claim 14 wherein the indicating further comprises utilizing a thermistor thermally coupled to the light emitting sources so as to measure a bulk temperature.

\* \* \* \* \*

专利名称(译)	多波长传感器基板		
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#### 摘要(译)

生理传感器具有发射器，其配置成响应于相应的驱动电流发射具有多个波长的光辐射。热质量靠近发射器设置，以便稳定发射器的整体温度。温度传感器热耦合到热质量。温度传感器提供响应于整体温度的温度传感器输出，使得波长可根据驱动电流和整体温度确定。

